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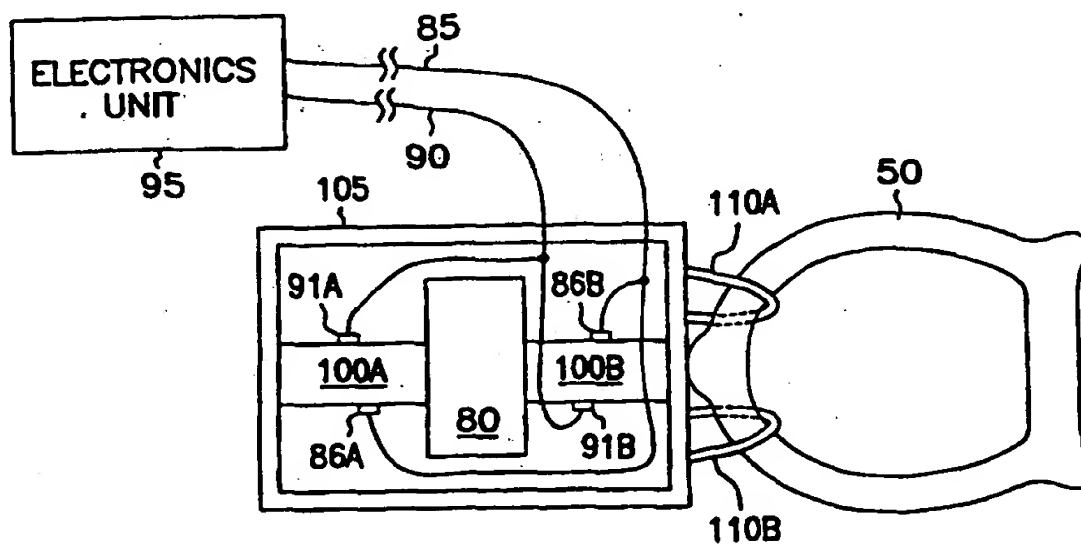
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(54) Title: MIDDLE EAR TRANSDUCER



## (57) Abstract

An electromechanical transducer for an implantable hearing aid, such as a partial middle ear implantable (P-MEI) or total middle ear implantable (T-MEI) hearing aid system. The invention comprises at least one piezoelectric element proportioned for mechanically coupling to a middle ear only through an auditory element in the middle ear, such as the tympanic membrane, malleus, incus, stapes, or in the inner ear, such as the oval window, round window, vestibule, or semicircular canals. The invention need not be secured to a temporal bone. Inertial masses and a carrier are optionally provided to assist in sensing or producing mechanical vibrations. The carrier is optionally hermetically sealed. Superpositioned individual frequency responses optimize an overall frequency bandwidth.

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## **MIDDLE EAR TRANSDUCER**

5

### **The Field of the Invention**

This invention relates to an electromechanical transducer for use in a hearing system at least partially implantable in a middle ear.

### **Background**

10 In some types of partial middle ear implantable (P-MEI) or total middle ear implantable (T-MEI) hearing aid systems, sounds produce mechanical vibrations which are transduced by an electromechanical input transducer into electrical signals. These electrical signals are in turn amplified and applied to an electromechanical output transducer. The electromechanical output transducer vibrates an ossicular bone in response to the applied amplified electrical signals  
15 to improve hearing.

Such electromechanical input and output transducers should be proportioned to provide convenient implantation in the middle ear. Low power consumption transducers are also desired for use with a limited longevity implanted battery as a power source, such as for T-MEI hearing aid systems.

20

### **Summary of the Invention**

The invention provides an electromechanical transducer for an implantable hearing aid, such as a partial middle ear implantable (P-MEI) or total middle ear implantable (T-MEI) hearing aid system. The transducer comprises a piezoelectric element proportioned for mechanical coupling to a  
25 middle ear only through an auditory element in the middle ear. More particularly, the invention provides convenient piezoelectric input and output electromechanical transducers, each mounted only to the auditory element for which vibrations are transduced. The invention does not require mounting a transducer to the temporal bone. This minimizes the invasive complexity of the  
30 surgical implantation procedure, and also minimizes steady state forces applied to the auditory element.

For sensing mechanical vibrations, an electromechanical input transducer is coupled only to a vibrating auditory element, such as a tympanic membrane, malleus, or incus. The vibrating auditory element is optionally mechanically isolated from an auditory element vibrated by an electromechanical output  
5 transducer. For vibrating an auditory element, an electromechanical output transducer is coupled only to a vibrated auditory element, such as an incus, stapes, oval window, round window, vestibule, or semicircular canal.

Piezoelectric elements used in the electromechanical input and output transducers comprise ceramic piezoelectric single element transducers, ceramic  
10 piezoelectric bi-element transducers, piezoelectric stacked transducers comprising multiple mechanically stacked subelements, piezoelectric film transducers, and piezoelectric film bi-element transducers.

Certain embodiments include an inertial mass used in conjunction with the piezoelectric elements for transducing between electrical signals and  
15 mechanical vibrations.

An overall electrical-to-mechanical or mechanical-to-electrical frequency response is optimized by superpositioning substantially nonidentical frequency responses of piezoelectric elements in combination with any accompanying inertial masses. Different frequency responses are obtained by using different  
20 masses, different piezoelectric elements, or other techniques.

In certain embodiments, a carrier is provided to support the piezoelectric elements and any accompanying inertial masses. The carrier is secured only to the auditory element for which vibrations are transduced. The carrier is optionally hermetically sealed to protect the piezoelectric elements and inertial  
25 masses.

Thus, the invention provides convenient piezoelectric input and output electromechanical transducers, each mounted only to the auditory element for which vibrations are transduced. The invention also provides an electronics unit and a programmer.

**Brief Description of the Drawings**

In the drawings, like numerals describe like components throughout the several views.

Figure 1 illustrates a frontal section of an anatomically normal human  
5 right ear.

Figure 2 is a cross-sectional illustration of a typical use of a bi-element transducer coupled to an auditory element in the middle ear.

Figure 3 is a cross-sectional illustration of a first embodiment of the invention, including a bi-element transducer secured only to a vibrated auditory  
10 element.

Figure 4 is a cross-sectional illustration of a second embodiment of the invention, including a bi-element transducer secured only to a vibrating auditory element.

Figure 5 is a cross-sectional illustration of a third embodiment of the invention, using a single element transducer secured only to a vibrated auditory  
15 element.

Figure 6 is a cross-sectional illustration of a fourth embodiment of the invention, using a single element transducer secured only to a vibrating auditory element.

Figure 7 is a cross-sectional illustration of a fifth embodiment of the invention, including a carrier and also including an inertial mass interposed  
20 between two single element transducers.

Figure 8A is a cross-sectional illustration of a sixth embodiment of the invention, including a carrier, a bi-element transducer, and an inertial mass.

Figure 8B is a cross-sectional illustration of a further embodiment of the invention, including a carrier that does not enclose the bi-element transducer and  
25 inertial mass.

Figure 9 is a cross-sectional illustration of a seventh embodiment of the invention, including a carrier and also including an inertial mass secured  
30 between two bi-element transducers.

Figure 10 is a cross-sectional illustration of an eighth embodiment of the invention, including a carrier, two bi-element transducers, and two inertial masses.

Figure 11A is a cross-sectional illustration of a ninth embodiment of the invention, including a carrier, two stacked transducers, and two inertial masses.

Figure 11B is a cross-sectional illustration of an alternative embodiment, to Figure 11A, having electrical connections across a length of each transducer subelement.

Figure 12A is a cross-sectional illustration of a tenth embodiment of the invention, including a carrier and also including two stacked transducers secured within its opposing faces.

Figure 12B is a cross-sectional illustration of an alternative embodiment, to Figure 12A, having electrical connections across a length of each transducer subelement.

Figure 13A is a cross-sectional illustration of an eleventh embodiment of the invention, including a carrier and also including two stacked transducers having cylindrically hollowed cores.

Figure 13B is a cross-sectional view taken along the cut line illustrated in Figure 13A.

Figure 14 is a cross-sectional view of a twelfth embodiment of the invention, including a carrier and also including two single element transducers having cylindrically hollowed cores.

Figure 15 is a cross-sectional view of a thirteenth embodiment of the invention, secured to a vibrating malleus, including a carrier, a film transducer, and an inertial mass.

Figure 16 is a cross-sectional view of a fourteenth embodiment of the invention, secured to a vibrating incus, including a carrier and a plurality of film transducers and respective inertial masses.

Figure 17 is a cross-sectional view of a fifteenth embodiment of the invention, secured to a vibrating malleus, including a carrier and also including a stacked transducer having a cylindrically hollowed core.



Figure 18 is a cross-sectional view of the sixteenth embodiment of the invention, in use with a P-MEI hearing aid having a microphone in the external auditory canal.

Figure 19 is a cross-sectional view of a preferred embodiment of the invention, in use with a T-MEI hearing aid, including both electromechanical input and output transducers.

Figure 20 is a schematic illustration of one embodiment of the invention including an implanted hearing assistance device and an external programmer.

#### **Description of the Preferred Embodiments**

10 The invention provides an electromechanical transducer which is particularly advantageous when used in a middle ear implantable hearing aid system such as a partial middle ear implantable (P-MEI), total middle ear implantable (T-MEI), or other hearing aid system. A P-MEI or T-MEI hearing aid system assists the human auditory system in converting acoustic energy  
15 contained within sound waves into electrochemical signals delivered to the brain and interpreted as sound. Figure 1 illustrates generally the use of the invention in a human auditory system. Sound waves are directed into an external auditory canal 20 by an outer ear (pinna) 25. The frequency characteristics of the sound waves are slightly modified by the resonant characteristics of the external  
20 auditory canal 20. These sound waves impinge upon the tympanic membrane (eardrum) 30, interposed at the terminus of the external auditory canal, between it and the tympanic cavity (middle ear) 35. Variations in the sound waves produce tympanic vibrations. The mechanical energy of the tympanic vibrations is communicated to the inner ear, comprising cochlea 60, vestibule 61, and  
25 semicircular canals 62, by a sequence of articulating bones located in the middle ear 35. This sequence of articulating bones is referred to generally as the ossicular chain 37. Thus, the ossicular chain transforms acoustic energy at the eardrum to mechanical energy at the cochlea 60.

The ossicular chain 37 includes three primary components: a malleus 40,  
30 an incus 45, and a stapes 50. The malleus 40 includes manubrium and head portions. The manubrium of the malleus 40 attaches to the tympanic membrane

30. The head of the malleus 40 articulates with one end of the incus 45. The incus 45 normally couples mechanical energy from the vibrating malleus 40 to the stapes 50. The stapes 50 includes a capitulum portion, comprising a head and a neck, connected to a footplate portion by means of a support crus comprising two crura. The stapes 50 is disposed in and against a membrane-covered opening on the cochlea 60. This membrane-covered opening between the cochlea 60 and middle ear 35 is referred to as the oval window 55. Oval window 55 is considered part of cochlea 60 in this patent application. The incus 45 articulates the capitulum of the stapes 50 to complete the mechanical transmission path.

Normally, prior to implantation of the invention, tympanic vibrations are mechanically conducted through the malleus 40, incus 45, and stapes 50, to the oval window 55. Vibrations at the oval window 55 are conducted into the fluid-filled cochlea 60. These mechanical vibrations generate fluidic motion, thereby transmitting hydraulic energy within the cochlea 60. Pressures generated in the cochlea 60 by fluidic motion are accommodated by a second membrane-covered opening on the cochlea 60. This second membrane-covered opening between the cochlea 60 and middle ear 35 is referred to as the round window 65. Round window 65 is considered part of cochlea 60 in this patent application. Receptor cells in the cochlea 60 translate the fluidic motion into neural impulses which are transmitted to the brain and perceived as sound. However, various disorders of the tympanic membrane 30, ossicular chain 37, and/or cochlea 60 can disrupt or impair normal hearing.

Hearing loss due to damage in the cochlea is referred to as sensorineural hearing loss. Hearing loss due to an inability to conduct mechanical vibrations through the middle ear is referred to as conductive hearing loss. Some patients have an ossicular chain 37 lacking sufficient resiliency to transmit mechanical vibrations between the tympanic membrane 30 and the oval window 55. As a result, fluidic motion in the cochlea 60 is attenuated. Thus, receptor cells in the cochlea 60 do not receive adequate mechanical stimulation. Damaged elements

of ossicular chain 37 may also interrupt transmission of mechanical vibrations between the tympanic membrane 30 and the oval window 55.

Various techniques have been developed to remedy hearing loss resulting from conductive or sensorineural hearing disorder. For example, tympanoplasty is used to surgically reconstruct the tympanic membrane 30 and establish ossicular continuity from the tympanic membrane 30 to the oval window 55. Various passive mechanical prostheses and implantation techniques have been developed in connection with reconstructive surgery of the middle ear 35 for patients with damaged elements of ossicular chain 37. Two basic forms of prosthesis are available: total ossicular replacement prostheses (TORP), which is connected between the tympanic membrane 30 and the oval window 55; and partial ossicular replacement prostheses (PORP), which is positioned between the tympanic membrane 30 and the stapes 50.

Various types of hearing aids have been developed to compensate for hearing disorders. A conventional "air conduction" hearing aid is sometimes used to overcome hearing loss due to sensorineural cochlear damage or mild conductive impediments to the ossicular chain 37. Conventional hearing aids utilize a microphone, which transduces sound into an electrical signal. Amplification circuitry amplifies the electrical signal. A speaker transduces the amplified electrical signal into acoustic energy transmitted to the tympanic membrane 30. However, some of the transmitted acoustic energy is typically detected by the microphone, resulting in a feedback signal which degrades sound quality. Conventional hearing aids also often suffer from a significant amount of signal distortion.

Implantable hearing aid systems have also been developed, utilizing various approaches to compensate for hearing disorders. For example, cochlear implant techniques implement an inner ear hearing aid system. Cochlear implants electrically stimulate auditory nerve fibers within the cochlea 60. A typical cochlear implant system includes an external microphone, an external signal processor, and an external transmitter, as well as an implanted receiver and an implanted single channel or multichannel probe. A single channel probe

has one electrode. A multichannel probe has an array of several electrodes. In the more advanced multichannel cochlear implant, a signal processor converts speech signals transduced by the microphone into a series of sequential electrical pulses corresponding to different frequency bands within a speech frequency spectrum. Electrical pulses corresponding to low frequency sounds are delivered to electrodes that are more apical in the cochlea 60. Electrical pulses corresponding to high frequency sounds are delivered to electrodes that are more basal in the cochlea 60. The nerve fibers stimulated by the electrodes of the cochlear implant probe transmit neural impulses to the brain, where these neural impulses are interpreted as sound.

Other inner ear hearing aid systems have been developed to aid patients without an intact tympanic membrane 30, upon which "air conduction" hearing aids depend. For example, temporal bone conduction hearing aid systems produce mechanical vibrations that are coupled to the cochlea 60 via a temporal bone in the skull. In such temporal bone conduction hearing aid systems, a vibrating element can be implemented percutaneously or subcutaneously.

A particularly interesting class of hearing aid systems includes those which are configured for disposition principally within the middle ear 35 space. In middle ear implantable (MEI) hearing aids, an electrical-to-mechanical output transducer couples mechanical vibrations to the ossicular chain 37, which is optionally interrupted to allow coupling of the mechanical vibrations to the ossicular chain 37. Both electromagnetic and piezoelectric output transducers have been used to effect the mechanical vibrations upon the ossicular chain 37.

One example of a partial middle ear implantable (P-MEI) hearing aid system having an electromagnetic output transducer comprises: an external microphone transducing sound into electrical signals; external amplification and modulation circuitry; and an external radio frequency (RF) transmitter for transdermal RF communication of an electrical signal. An implanted receiver detects and rectifies the transmitted signal, driving an implanted coil in constant current mode. A resulting magnetic field from the implanted drive coil vibrates an implanted magnet that is permanently affixed only to the incus 45. Such

electromagnetic output transducers have relatively high power consumption, which limits their usefulness in total middle ear implantable (T-MEI) hearing aid systems.

A piezoelectric output transducer is also capable of effecting mechanical vibrations to the ossicular chain 37. An example of such a device is disclosed in U.S. Pat. No. 4,729,366, issued to D. W. Schaefer on Mar. 8, 1988. In the '366 patent, a mechanical-to-electrical piezoelectric input transducer is associated with the malleus 40, transducing mechanical energy into an electrical signal, which is amplified and further processed. A resulting electrical signal is provided to an electrical-to-mechanical piezoelectric output transducer that generates a mechanical vibration coupled to an element of the ossicular chain 37 or to the oval window 55 or round window 65. In the '366 patent, the ossicular chain 37 is interrupted by removal of the incus 45. Removal of the incus 45 prevents the mechanical vibrations delivered by the piezoelectric output transducer from mechanically feeding back to the piezoelectric input transducer.

Piezoelectric output transducers have several advantages over electromagnetic output transducers. The smaller size or volume of the piezoelectric output transducer advantageously eases implantation into the middle ear 35. The lower power consumption of the piezoelectric output transducer is particularly attractive for T-MEI hearing aid systems, which include a limited longevity implanted battery as a power source.

A piezoelectric output transducer is typically implemented as a ceramic piezoelectric bi-element transducer, which is a cantilevered double plate ceramic element in which two opposing plates are bonded together such that they amplify a piezoelectric action in a direction normal to the bonding plane. Such a bi-element transducer vibrates according to a potential difference applied between two bonded plates. A proximal end of such a bi-element transducer is typically cantilevered from a transducer mount which is secured to a temporal bone within the middle ear. A distal end of such a bi-element transducer couples mechanical vibrations to an ossicular element such as stapes 50. However, securing a bi-

element transducer mount to the temporal bone adds invasive complexity to the surgical implantation procedure.

Figure 2 is a generalized illustration of a bi-element transducer 70 cantilevered at its proximal end from a mount 75 secured to a temporal bone within middle ear 35. A distal end of bi-element transducer 70 is mechanically coupled to an auditory element to receive or effect mechanical vibrations when operating as an input or output transducer respectively. For example, to receive mechanical vibrations as an input transducer, bi-element transducer 70 may be coupled to an auditory element such as tympanic membrane 30, malleus 40, or incus 45. In another example, to effect vibrations as an output transducer, bi-element transducer 70 may be coupled to an auditory element such as incus 45, stapes 50, oval window 55, round window 65, vestibule 61, or semicircular canal 62. However, mounting bi-element transducer 70 to the temporal bone adds invasive complexity in its surgical implantation.

The invention provides convenient piezoelectric input and output electromechanical transducers, each mounted only to the auditory element for which vibrations are transduced. In particular, the invention does not require mounting a transducer to the temporal bone. This minimizes the invasive complexity of the surgical implantation procedure, and also minimizes steady state forces applied to the auditory element.

Figure 3 illustrates generally a cross-sectional view of a first embodiment of the invention used as an electromechanical output transducer. A piezoelectric element, more particularly bi-element transducer 70, is mechanically coupled, and preferably secured, at its proximal end to middle ear 35 only through an auditory element, preferably stapes 50, or alternatively incus 45, stapes 50, oval window 55, round window 65, vestibule 61, or semicircular canals 62. Bi-element transducer 70 is secured only to stapes 50 by any known attachment technique, including biocompatible adhesives or mechanical fasteners. For example, in one embodiment, a deformable wire secured to the proximal end of bi-element transducer 70 is looped through an inner portion of stapes 50 and crimped to secure bi-element transducer 70 to stapes 50. The exact technique of

attachment to the auditory element is not part of the invention, except that the piezoelectric element should be coupled only to the vibrated auditory element; it need not be secured elsewhere within the middle ear 35 such as to the temporal bone.

5 An inertial mass 80 is secured to a distal end of bi-element transducer 70 by any known attachment technique, including a biocompatible adhesive or mechanical fastener. Inertial mass 80 is of a biocompatible material such as titanium or stainless steel, or any other biocompatible material proportioned to provide sufficient inertial mass to impart a force upon stapes 50, as explained  
10 below:

Electronics unit 95 couples an electrical signal through lead wires 85 and 90 to any convenient respective connection points 86 and 91 on respective opposing elements of bi-element transducer 70. Electronics unit 95 and lead wires 85 and 90 are not part of the invention, but rather show how the invention  
15 is used in conjunction with a P-MEI, T-MEI, or other hearing aid system.

In response to the electrical signals received from electronics unit 95, bi-element transducer 70 bends with respect to a longitudinal plane between its opposing elements. The bending is resisted by inertial mass 80, thus mechanically coupling a force to stapes 50 through bi-element transducer 70.  
20 This force upon stapes 50 is in turn transmitted to cochlea 60 at oval window 55.

Figure 4 illustrates generally a cross-sectional view of a second embodiment of the invention used as an electromechanical input transducer. A piezoelectric element, such as bi-element transducer 70, is secured by any known attachment technique at its proximal end, such as described above, only to  
25 malleus 40. Bi-element transducer 70 may also be secured only to other auditory elements for receiving mechanical vibrations, such as incus 45 or tympanic membrane 30.

Vibrations of malleus 40 cause, at the proximal end of bi-element transducer 70, vibratory displacements that are opposed by inertial mass 80. As  
30 a result, bi-element transducer 70 bends with respect to the longitudinal plane between its opposing elements. A resulting electrical signal is provided at any

convenient connection points 86 and 91 on respective opposing elements of bi-element transducer 70, through respective lead wires 92 and 93 to electronics unit 95.

Figure 5 illustrates generally a cross-sectional view of a third  
5 embodiment of the invention, used as an electromechanical output transducer, as described above. A piezoelectric element, such as ceramic single element transducer 100 is secured at its proximal end only to an auditory element, such as stapes 50. Any known attachment technique may be used, such as described  
above. An inertial mass 80, described above, is secured to a distal end of single  
10 element transducer 100 by any known attachment technique, such as described above.

This embodiment uses a piezoelectric effect with displacement approximately orthogonal to the direction of an applied electrical input signal, although a piezoelectric effect in another direction may also be used at the  
15 designer's discretion by rearranging the connection points accordingly. Electronics unit 95 delivers an electrical signal through lead wires 85 and 90 to any convenient respective connection points 86 and 91 on respective opposing faces of single element transducer 100. In response to this electrical signal, single element transducer 100 expands and contracts in a longitudinal direction  
20 between its proximal and distal ends. This vibratory displacement is resisted by inertial mass 80, thus coupling a force to stapes 50 through single element transducer 100. In a further embodiment, transducer 100 of Figure 5 comprises a stack of multiple piezoelectric subelements connected mechanically in series, and wired electrically in parallel for increased vibratory displacement. In  
25 another further embodiment, inertial mass 80 is omitted; the distributed mass of transducer 100 mechanically couples a vibratory force to stapes 50.

Figure 6 illustrates generally a cross-sectional view of a fourth  
embodiment of the invention, used as an electromechanical input transducer, as described above. Single element transducer 100 is secured at its proximal end by  
30 any known attachment technique, such as described above, only to malleus 40 or other vibrating auditory element as described above. Vibrations at the proximal



end of transducer 100 are opposed by inertial mass 80, longitudinally exerting forces on transducer 100. A resulting electrical signal is provided at any convenient connection points 86 and 91, on respective opposing faces of single element transducer 100, through respective lead wires 92 and 93 to electronics unit 95.

Figure 7 illustrates generally a cross-sectional view of a fifth embodiment of the invention, used as an electromechanical output transducer, as described above. A proximal portion of a carrier 105 is secured only to an auditory element, such as stapes 50, by any known attachment technique, as described above. For example, deformable wires 110A-B, secured to carrier 105, may looped through an inner portion of stapes 50 and crimped to secure carrier 105 to stapes 50. The exact technique of attachment is not part of the present invention, except that carrier 105 should be coupled only to the auditory element; it need not be secured elsewhere within the middle ear 35 such as to the temporal bone.

Carrier 105 has opposing interior faces, between which are interposed first and second single element transducers 100A-B, which are respectively mechanically coupled to a distal and a proximal interior face of carrier 105. Inertial mass 80 is interposed between and mechanically coupled to single element transducers 100A-B. This embodiment uses a piezoelectric effect with displacement approximately orthogonal to the direction of an applied electrical input signal, although a piezoelectric effect in another direction may also be used at the designer's discretion by rearranging the connection points accordingly. Electronics unit 95 couples an electrical signal through lead wires 85 and 90 to connection points 86A-B and 91A-B. Connection points 86A-B and 91A-B are pairwise located wherever convenient on opposing faces of first and second single element transducers 100A-B, as illustrated in Figure 7.

First and second single element transducers 100A-B receive opposite polarity electrical signals from electronics unit 95. For example, lead wire 85 is coupled at connection point 86B to a top face of single element transducer 100B and at connection point 86A to a bottom face of single element transducer 100A. Also, lead wire 90 is coupled at connection point 91B to a bottom face of single

element transducer 100B and at connection point 91A to a top face of single element transducer 100A.

In response to a received electrical signal of a first polarity, single element transducer 100A expands longitudinally while single element transducer 100B contracts longitudinally. In response to a received electrical signal of a second polarity, opposite to the first polarity, single element transducer 100A contracts longitudinally while single element transducer 100B expands longitudinally. Thus, single element transducers 100A-B undergo opposite longitudinal deformations in concert to vibrate inertial mass 80. Vibration of inertial mass 80 results in a corresponding opposing vibration of carrier 105 and stapes 50, each of which are mechanically coupled to inertial mass 80.

Carrier 105 is proportioned for disposition within middle ear 35, and is constructed from any known biocompatible material, such as titanium. Carrier 105 is optionally hermetically sealed to protect any enclosed transducer elements and inertial mass from humidity and bodily fluids, providing feedthroughs for lead wires, such as lead wires 85 and 90, for coupling electrical signals through the hermetically sealed enclosure.

Figure 8A illustrates generally a cross-sectional view of a sixth embodiment of the invention, used as an electromechanical output transducer, as described above. Bi-element transducer 70 is interposed between opposing interior faces of carrier 105. Bi-element transducer 70 is secured to opposing interior faces of carrier 105, such as at points 115 and 120, by any known attachment technique, including adhesives, mechanical fasteners, conforming or interlocking receptacles on carrier 105, or any other such attachment technique. Inertial mass 80 is secured to one of the opposing elements of bi-element transducer 70 by an adhesive, or by any other attachment technique. Electronics unit 95 couples an electrical signal through lead wires 85 and 90 to respective connection points 86 and 91 located wherever convenient on respective opposing elements of bi-element transducer 70.

In response to the received electrical signal, bi-element transducer 70 bends

with respect to a longitudinal plane between its opposing elements. The bending is opposed by inertial mass 80, thus mechanically coupling a vibratory force to stapes 50, which is in turn transmitted to cochlea 60 at oval window 55.

Figure 8B illustrates generally a cross-sectional view of a further embodiment in which carrier 105 provides support to bi-element transducer 70, but does not hermetically seal or otherwise enclose bi-element transducer 70 or inertial mass 80.

Figure 9 illustrates generally a cross-sectional view of a seventh embodiment of the invention, used as an electromechanical output transducer as described above. First and second bi-element transducers 125 and 130 are each interposed between opposing interior faces of carrier 105. First and second bi-element transducers 125 and 130 are secured to opposing interior faces of carrier 105 by any known attachment technique, as described above. Inertial mass 80 is secured to facing elements of each of first and second bi-element transducers 125 and 130 by an adhesive, or by any other attachment technique. Electronics unit 95 couples an electrical signal through lead wires 85 and 90 to connection points 86A-B and 91A-B, pairwise located wherever convenient on respective opposing elements of respective first and second bi-element transducers 125 and 130.

First and second bi-element transducers 125 and 130 have substantially parallel respective longitudinal planes between their respective opposing elements. In response to the received electrical signal, first and second bi-element transducers 125 and 130 each bend in the same direction with respect to their longitudinal planes. The bending of each of first and second bi-element transducers 125 and 130 vibrates inertial mass 80 and mechanically couples a force to stapes 50, which is in turn transmitted to cochlea 60 at oval window 55.

Figure 10 illustrates generally a cross-sectional view of an eighth embodiment of the invention, used as an electromechanical output transducer, as described above. First and second bi-element transducers 125 and 130 are each interposed between opposing interior faces of carrier 105. First and second bi-element transducers 125 and 130 are secured to opposing interior faces of carrier 105 by any known attachment technique, as described above. First inertial mass

80A is secured to one of the opposing individual elements of first bi-element transducer 125. Second inertial mass 80B is secured to one of the opposing individual elements of bi-element transducer 130. Electronics unit 95 couples an electrical signal through lead wires 85 and 90 to connection points 86A-B and  
5 91A-B, pairwise located wherever convenient on respective opposing elements of respective first and second bi-element transducers 125 and 130.

In response to the received electrical signal, first and second bi-element transducers 125 and 130 each bend in the same direction with respect to their substantially parallel respective longitudinal planes, described above. The  
10 bending of each of first and second bi-element transducers 125 and 130 is opposed by first and second inertial masses 80A-B, thus mechanically coupling a vibratory force to stapes 50, which is in turn transmitted to cochlea 60 at oval window 55.

In one embodiment, first and second inertial masses 80A-B have  
15 substantially nonidentical masses, resulting in different frequency responses of each of first and second inertial masses in combination with respective first and second bi-element transducers 125 and 130. Masses are selected to improve a combined vibration frequency response of carrier 105 resulting from the superposition of the individual frequency responses described above. For  
20 example, in the embodiment of Figure 10, inertial mass 80A is less massive than inertial mass 80B, such that the vibration effected with inertial mass 80A contains more high frequency components than the vibration effected with inertial mass 80B.

Other techniques of implementing different vibration frequency  
25 responses could also be used. For example, first and second bi-element transducers 125 and 130 may be selected to vibrate with substantially nonidentical frequency responses. First and second bi-element transducers 125 and 130 could also be supplied with individual input electrical signals having different frequency characteristics. Substantially nonidentical frequency  
30 responses could be obtained from first and second bi-element transducers 125 and 130 by using transducers of different physical dimensions, different number

of transducer elements, different material properties, different mounting techniques, or any other technique. For example, different mounting techniques can be used to obtain substantially nonidentical frequency responses by cantilevering first bi-element transducer 125 from a single interior face of carrier 105, and securing second bi-element transducer 130, as described above and shown in Figure 10, to two opposing interior faces of carrier 105.

Figure 11A illustrates generally a cross-sectional view of a ninth embodiment of the invention used as an electromechanical output transducer, as described above. Carrier 105 is secured only to an auditory element, such as incus 45, by any known attachment technique, as described above. The exact technique of attachment to the auditory element is not part of the invention, except that carrier 105 should be coupled only to the auditory element; it need not be secured elsewhere within the middle ear 35 such as to the temporal bone. In this embodiment, carrier 105 includes support 135. Piezoelectric transducer elements in this embodiment include first stacked transducer 140, secured to an interior face of carrier 105, and second stacked transducer 145, secured to support 135. First inertial mass 80A is secured only to first stacked transducer 140. Second inertial mass 80B is secured only to second stacked transducer 145.

First and second stacked transducers 140 and 145 comprise a selectable number of transducer subelements, such as 140A-B and 145A-C respectively, stacked mechanically in series. In one embodiment, first and second stacked transducers 140 and 145 have different numbers of transducer subelements, resulting in different vibration frequency responses such that an overall frequency response bandwidth of carrier 105 is increased. Other techniques may also be used to obtain different frequency responses, as described above.

Electronics unit 95 couples an electrical signal through lead wires 85 and 90 to connection points 86A-E and 91A-E located wherever convenient on respective opposing faces of each of first and second transducer subelements 140A-B and 145A-C. This embodiment uses a piezoelectric effect with displacement approximately orthogonal to the direction of an applied electrical

input signal, although a piezoelectric effect in another direction may also be used at the designer's discretion by rearranging the connection points accordingly.

In response to the received electrical signal, first and second stacked transducers 140 and 145 each expand and contract in concert in a longitudinal  
5 direction approximately normal to their respective approximately planar interfaces with first and second inertial masses 80A-B. As a result, first and second inertial masses 80A-B vibrate. This mechanically couples an opposing force through carrier 105 to stapes 50, which is in turn transmitted to cochlea 60 at oval window 55.

10 Figure 11B illustrates generally an alternative embodiment to that illustrated in Figure 11A. This embodiment uses a piezoelectric effect with displacement approximately the same direction of an applied electrical input signal, although a piezoelectric effect in another direction may also be used at the designer's discretion by rearranging the connection points accordingly.  
15 Electronics unit 95 couples an electrical signal through lead wires 85 and 90 to connection points 87A-D and 92A-C located across a length of each of transducer subelements 140A-B and 145A-C in the longitudinal direction between proximal and distal portions of carrier 105.

In response to the received electrical signal, first and second stacked  
20 transducers 140 and 145 each expand and contract in concert in a longitudinal direction approximately normal to their respective approximately planar interfaces with first and second inertial masses 80A-B. As a result, first and second inertial masses 80A-B vibrate. This mechanically couples an opposing force through carrier 105 to stapes 50, which is in turn transmitted to cochlea 60  
25 at oval window 55.

Figure 12A illustrates generally a cross-sectional view of a tenth  
embodiment of the invention used as an electromechanical output transducer, as described above. In this embodiment, first and second stacked transducers 140 and 145 are secured to carrier 105 at its opposing interior faces, such that a  
30 direction approximately orthogonal to the plane of each of the opposing interior faces is in the direction of vibratory motion of the auditory element to which

carrier 105 is secured. In this embodiment, inertial masses 80A-B are omitted; vibrations of the distributed masses of first and second stacked transducers 140 and 145 mechanically couple a force through carrier 105 to stapes 50.

This embodiment uses a piezoelectric effect with displacement  
5 approximately orthogonal to the direction of an applied electrical input signal, although a piezoelectric effect in another direction may also be used at the designer's discretion by rearranging the connection points accordingly. Electronics unit 95 couples an electrical signal through lead wires 85 and 90 to connection points 86A-E and 91A-E, pairwise located on respective opposing  
10 faces of each of first and second transducer subelements 140A-B and 145A-C. Since first and second stacked transducers 140 and 145 are secured to opposing interior faces of carrier 105, first and second stacked transducers 140 and 145 receive opposite polarity electrical signals from electronics unit 95. For example, lead wire 85 is coupled at connection points 86A-B to a top face of  
15 stacked transducer 140 and at connection points 86C-E to a bottom face of stacked transducer 145. Also, lead wire 90 is coupled at connection points 91A-B to a bottom face of stacked transducer 140 and at connection points 91C-E to a top face of stacked transducer 145.

In response to a received electrical signal of a first polarity, stacked  
20 transducer 140 expands longitudinally while stacked transducer 145 contracts longitudinally. In response to a received electrical signal of a second polarity, opposite to the first polarity, stacked transducer 140 contracts longitudinally while stacked transducer 145 expands longitudinally. Thus, stacked transducers 140 and 145 undergo opposite longitudinal deformations in concert to vibrate  
25 carrier 105 and incus 45.

Figure 12B illustrates generally an alternative embodiment to that illustrated in Figure 12A. This embodiment uses a piezoelectric effect with displacement approximately the same direction of an applied electrical input signal, although a piezoelectric effect in another direction may also be used at  
30 the designer's discretion by rearranging the connection points accordingly. Electronics unit 95 couples an electrical signal through lead wires 85 and 90 to

connection points 87A-D and 92A-C located across a length of each of transducer subelements 140A-B and 145A-C in the longitudinal direction between proximal and distal portions of carrier 105.

As described above, first and second stacked transducers 140 and 145 receive opposite polarity electrical signals from electronics unit 95. In response to a received electrical signal of a first polarity, stacked transducer 140 expands longitudinally while stacked transducer 145 contracts longitudinally. In response to a received electrical signal of a second polarity, opposite to the first polarity, stacked transducer 140 contracts longitudinally while stacked transducer 145 expands longitudinally. Thus, stacked transducers 140 and 145 undergo opposite longitudinal deformations in concert to vibrate carrier 105 and incus 45.

Figure 13A illustrates generally a cross-sectional view of an eleventh embodiment of the invention used as an electromechanical output transducer, as described above. In this embodiment, first and second stacked transducers 150 and 155 are cylindrical shaped having cylindrically hollowed cores. Since first and second stacked transducers 150 and 155 are on opposing interior faces of carrier 105, electronics unit 95 provides through lead wires 85 and 90 opposite polarity electrical input signals to first and second stacked transducers 150 and 155 at connection points 86A-E and 91A-E. For example, lead wire 85 is coupled at connection points 86A-B to an outer face of stacked transducer 150 and at connection points 86C-E to an interior face within the hollow core of stacked transducer 155. Also, lead wire 90 is coupled at connection points 91A-B to an interior face within the hollow core of stacked transducer 150 and at connection points 91C-E to an outer face of stacked transducer 145.

Thus, stacked transducers 150 and 155 undergo opposite longitudinal deformations in concert to vibrate carrier 105 and incus 45. Figure 13B illustrates generally a cross-sectional view the invention of Figure 13A, along the cut line illustrated in Figure 13A. Figure 13B further illustrates a hollow cylindrical core region 160 within second stacked transducer 155.

The embodiment of Figures 13A-B could also be used as an electromechanical input transducer, as described above, by securing carrier 105



only to a vibrating auditory element, such as incus 45, and preferably isolating the vibrating auditory element from any auditory element vibrated by an electromechanical output transducer.

Figure 14 illustrates generally a cross-sectional view of an twelfth embodiment of the invention used as an electromechanical output transducer, as described above. In this embodiment, first and second single element transducers 165 and 170 are cylindrical shaped having cylindrical hollow cores. First and second single element transducers receive opposite polarity electrical input signals at connection points 86A-B and 91A-B at outer faces and at inner faces within their hollow cylindrical cores, as illustrated. Thus, stacked transducers 165 and 170 undergo opposite longitudinal deformations in concert to vibrate carrier 105 and incus 45.

Figure 15 illustrates generally a cross-sectional view of an thirteenth embodiment of the invention, used as an electromechanical input transducer. Carrier 105 is secured only to an auditory element, such as malleus 40, by any known attachment technique, as described above. The exact technique of attachment to the auditory element is not part of the present invention, except that carrier 105 should be coupled only to the auditory element from which vibrations are sensed; it need not be secured elsewhere within the middle ear such as to the temporal bone.

Piezoelectric film transducer 175 is interposed between opposing interior faces of carrier 105. Film transducer 175 comprises a highly piezoelectric film such as a polarized fluoropolymer, e.g. polyvinylidene fluoride (PVDF). For this application, a PVDF film such as that sold under the trademark "Kynar" by AMP, Inc., of Harrisburg, Pennsylvania, is the preferred material for film transducer 175.

Film transducer 175 is secured to opposing interior faces of carrier 105 by any known attachment technique, such as described above. Inertial mass 80 is secured to film transducer 175 by an adhesive, or by any other known attachment technique. Mechanical vibrations of malleus 40 are coupled to inertial mass 80 through carrier 105 and film transducer 175. Inertial mass 80

opposes the mechanical vibrations, thus bendingly deforming film transducer 175. A resulting output electrical signal is received across a film thickness at connection points 180 and 185, and coupled to input terminals of electronics unit 95 through respective leads 190 and 195.

5           Figure 16 illustrates generally a cross-sectional view of an fourteenth embodiment of the invention, used as an electromechanical input transducer, as described above. Carrier 105 is secured only to a vibrating auditory element, such as incus 45. The vibrating auditory element is preferably mechanically isolated from any auditory element vibrated by an electromechanical output  
10   transducer.

          In this embodiment, the piezoelectric elements comprise a plurality of piezoelectric film transducers 175A-C, selectable in number, each interposed between and secured to opposing interior faces of carrier 105. Film transducers 175A-C comprise a highly piezoelectric film such as PVDF. Inertial masses  
15   80A-C are each secured to respective film transducers 175A-C by an adhesive, or by any other known attachment technique.

          Mechanical vibrations of incus 45 are coupled to inertial masses 80A-C through carrier 105 and film transducers 175A-C. The vibrations are opposed by inertial masses 80A-C, each having different masses, thus bendingly deforming  
20   film transducers 175A-C. Resulting output electrical signals, which have different frequency characteristics, are produced across each film's thickness at respective connection points 200A-B, 205A-B, 210A-B. The electrical signals at respective connection points 200A-B, 205A-B, 210A-B are coupled through respective leads 215A-B, 220A-B, and 225A-B to input terminals of electronics  
25   unit 95 for summing and further processing.

          Figure 17 illustrates generally a cross-sectional view of an fifteenth embodiment of the invention, used as an electromechanical input transducer, as described above. Carrier 230, comprising an approximately planar mechanical frame, is secured only to a vibrating auditory element, such as malleus 40. In  
30   this embodiment, a piezoelectric element comprises stacked transducer 235, which is secured to carrier 230, as described above. Stacked transducer 235

comprises a selectable number of subelements, such as 235A-C, each of which are cylindrical shaped having coincidental cylindrical hollow cores, as described above.

Mechanical vibrations of malleus 40 are mechanically coupled to stacked transducer 235 through carrier 230. A resulting individual electrical signal is provided by each subelement 235A-C between a first connection point 240A-C on its outer face, and a second connection point 245A-C on its interior face within the hollow core of stacked transducer 235. First and second connection points 240A-C and 245A-C are coupled through lead wires 250A-C and 255A-C to electronics unit 95 for summing and further processing.

Figure 18 illustrates generally a cross-sectional view of the sixteenth embodiment of the invention, described above, in use with a particular type of P-MEI hearing aid. In Figure 18, a microphone 240 in external auditory canal 20 transduces acoustic energy into an electrical signal provided through input leads 245 and 250 to electronics unit 95 implanted in a mastoid portion of the temporal bone 252. Alternatively, electronics unit 95 may be located outside the skull such as behind outer ear 25. Electronics unit 95 further processes the received electrical signal, and provides an amplified electrical signal through lead wires 85 and 90 at respective connection points 86 and 91 to bi-element transducer 70. Bi-element transducer 70 is secured to carrier 105, which is in turn secured only to a vibrated auditory element such as stapes 50.

Figure 19 illustrates generally a cross-sectional view of a highly preferred embodiment of the invention, in use with a particular type of T-MEI hearing aid. In Figure 19, electromechanical input transducer 255 is secured only to a vibrating auditory element, such as incus 45, which is mechanically isolated, as described above, from stapes 50 by a surgically shortened long arm portion 260. Sensing mechanical vibrations at incus 45 may offer more natural hearing due to the complex nature of the incudomalleolar joint coupling malleus 40 to incus 45. An electromechanical output transducer 265 is secured only to a vibrated auditory element, such as stapes 50. Electromechanical input transducer 255 comprises a piezoelectric film and inertial mass as described above with respect

to the thirteenth embodiment of the invention. Electromechanical output transducer 265 comprises a bi-element transducer and inertial mass as described above with respect to the sixth embodiment of the invention.

Mechanical vibrations of the incus 45 are sensed by the  
5 electromechanical input transducer 255 and transduced into an electrical signal provided through lead wires 245 and 250 to electronics unit 95 implanted in the mastoid portion of temporal bone 80. Electronics unit 95 further processes the electrical signal and provides an amplified electrical signal through lead wires 85 and 90 to electromechanical output transducer 265. Electromechanical output  
10 transducer 265 transduces the amplified electrical signal into a mechanical vibration which is mechanically coupled to the stapes 50, and in turn coupled to the oval window 55 portion of cochlea 60.

Figure 20 illustrates an embodiment of the hearing assistance system that also includes an external (i.e., not implanted) programmer 2000, which is  
15 communicatively coupled to an external or implantable portion of the hearing assistance device, such as electronics unit 95. Programmer 2000 includes hand-held, desktop, or a combination of hand-held and desktop embodiments, for use by a physician or the patient in which the hearing assistance device is implanted.

In one embodiment, each of programmer 2000 and the hearing assistance  
20 device include an inductive element, such as a coil, for inductively-coupled bi-directional transdermal communication between programmer 2000 and the hearing assistance device. Inductive coupling is just one way to communicatively couple programmer 2000 and the hearing assistance device. Any other suitable technique of communicatively coupling programmer 2000  
25 and the hearing assistance device may also be used including, but not limited to, radio-frequency (RF) coupling, infrared (IR) coupling, ultrasonic coupling, and acoustic coupling.

In one embodiment, the signals are encoded using pulse-code modulation (PCM), such as pulse-width telemetry or pulse-interval telemetry. In pulse-  
30 width telemetry, communication is by short bursts of a carrier frequency at fixed intervals, wherein the width of the burst indicates the presence of a "1" or a "0".

In pulse-interval telemetry, communication is by short fixed-length bursts of a carrier frequency at variable time intervals, wherein the length of the time interval indicates the presence of a "1" or a "0". The data can also be encoded by any other suitable technique, including but not limited to amplitude modulation (AM), frequency modulation (FM), or other communication technique.

The data stream is formatted to indicate that data is being transmitted, where the data should be stored in memory (in the programmer 2000 or the hearing assistance device), and also includes the transmitted data itself. In one embodiment, for example, the data includes an wake-up identifier (e.g., 8 bits), followed by an address (e.g., 6 bits) indicating where the data should be stored in memory, followed by the data itself.

In one embodiment, such communication includes programming of the hearing assistance device by programmer 2000 for adjusting hearing assistance parameters in the hearing assistance device, and also provides data transmission from the hearing assistance device to programmer 2000, such as for parameter verification or diagnostic purposes. Programmable parameters include, but are not limited to: on/off, standby mode, type of noise filtering for a particular sound environment, frequency response, volume, gain range, maximum power output, delivery of a test stimulus on command, and any other adjustable parameter. In one embodiment, certain ones of the programmable parameters (e.g., on/off, volume) are programmable by the patient, while others of the programmable parameters (e.g., gain range, filter frequency responses, maximum power output, etc.) are programmable only by the physician.

For clarity, the above described embodiments have been described with respect to function as either electromechanical input or output transducers. The piezoelectric effect allows both mechanical-to-electrical and electrical-to-mechanical transducing. Accordingly, each of the above described embodiments are intended to function as either electromechanical input transducers for sensing mechanical vibrations, or as electromechanical output transducers for producing mechanical vibrations. In particular, the above described embodiments may be

switched between vibrating and vibrated auditory elements to obtain the desired functionality, and electrical signals can be accordingly coupled to an electronics unit of a P-MEI, T-MEI, or other hearing system. For example, the invention could provide middle ear vibration sensing in conjunction with a cochlear  
5 implant, or other hearing system having output electrical stimuli. Also, inventive concepts illustrated in particular embodiments are intended to also apply to the other embodiments disclosed herein.

Thus, the invention provides convenient piezoelectric input and output electromechanical transducers, each mounted only to the auditory element for  
10 which vibrations are transduced. In particular, the invention does not require mounting a transducer to the temporal bone. This minimizes the invasive complexity of the surgical implantation procedure, and also minimizes steady state forces applied to the auditory element.

WHAT IS CLAIMED IS:

1. An electromechanical transducer for an implantable hearing device, the transducer characterizing a piezoelectric element proportioned for mechanically  
5 coupling to a middle ear only through an auditory element in the middle ear.
2. The transducer of claim 1, further characterizing an inertial mass mechanically coupled to the piezoelectric element.
- 10 3. The transducer of claim 1, in which the auditory element characterizes an ossicle of the middle ear.
4. The transducer of claim 1, in which the piezoelectric element characterizes a piezoelectric ceramic bi-element transducer.
- 15 5. The transducer of claim 1, in which the piezoelectric element characterizes a plurality of multiple piezoelectric subelements.
6. The transducer of claim 1, in which the piezoelectric element  
20 characterizes a piezoelectric film.
7. The transducer of claim 1, in which an electrical signal is transduced into a mechanical vibration coupled to the auditory element.
- 25 8. The transducer of claim 1, in which a mechanical vibration of the auditory element is transduced into an electrical signal.
9. An electromechanical transducer for an implantable hearing aid, the transducer characterizing:  
30 a carrier proportioned for mechanically coupling to a middle ear only through an auditory element in the middle ear; and

a first piezoelectric element mechanically coupled to the carrier for transducing between a mechanical vibration of the carrier and a first electrical signal.

5 10. The transducer of claim 9, in which the first piezoelectric element characterizes a piezoelectric ceramic bi-element transducer.

11. The transducer of claim 9, in which the first piezoelectric element characterizes a plurality of multiple piezoelectric subelements.

10

12. The transducer of claim 9, in which the first piezoelectric element characterizes a piezoelectric film.

13. The transducer of claim 9, further characterizing a first inertial mass  
15 mechanically coupled to the first piezoelectric element.

14. The transducer of claim 9, further characterizing a second piezoelectric element mechanically coupled to the carrier for transducing between a mechanical vibration of the carrier and a second electrical signal.

20

15. The transducer of claim 14, in which the first and second piezoelectric elements have substantially nonidentical respective first and second mechanical vibration frequency responses to the respective first and second electrical signals, and the mechanical vibration of the carrier is at least partially produced by a  
25 superposition of vibrations from each of the first and second piezoelectric elements.

16. The transducer of claim 14, in which the first and second piezoelectric  
30 elements have substantially nonidentical respective first and second electrical frequency responses to the mechanical vibration of the carrier, and respective



first and second electrical signals are transduced from the mechanical vibration of the carrier.

17. The transducer of claim 14, further characterizing:  
5 a first inertial mass mechanically coupled to the first piezoelectric element; and  
a second inertial mass mechanically coupled to the second piezoelectric element.
- 10 18. The transducer of claim 17, in which the first and second inertial masses have substantially nonidentical masses.
19. The transducer of claim 18, in which a first combination of the first inertial mass and the first piezoelectric element has a substantially nonidentical  
15 electromechanical frequency response from a second combination of the second inertial mass and the second piezoelectric element.
20. The transducer of claim 18, in which the mechanical vibration of the carrier is at least partially produced by a superposition of vibrations from each of  
20 the first and second combinations.
21. The transducer of claim 18, in which the respective first and second electrical signals are transduced from the mechanical vibration of the carrier.
- 25 22. The transducer of claim 14, further characterizing an inertial mass mechanically coupled to both of the first and second piezoelectric elements.
23. The transducer of claim 9, in which an electrical signal is transduced into a mechanical vibration coupled to the auditory element.

24. The transducer of claim 9, in which a mechanical vibration of the auditory element is transduced into an electrical signal.
25. The transducer of claim 9, in which the carrier provides a hermetically  
5 sealed case for the first piezoelectric element.
26. A method of vibrating an auditory element in a middle ear, the method characterizing the steps of:  
mechanically coupling a first piezoelectric element to the middle ear only  
10 through the auditory element; and  
electrically coupling a first electrical signal to the first piezoelectric element to vibrate the auditory element.
27. The method of claim 26, further characterizing the steps of:  
15 mechanically coupling a second piezoelectric element to the middle ear only through the auditory element; and  
electrically coupling a second electrical signal to the second piezoelectric element to vibrate the auditory element.
- 20 28. The method of claim 27, in which the first and second piezoelectric elements have substantially nonidentical mechanical vibration frequency responses to the respective first and second electrical signals.
29. The method of claim 27, further characterizing the steps of:  
25 mechanically coupling a first inertial mass to the first piezoelectric element; and  
mechanically coupling a second inertial mass to the second piezoelectric element.
- 30 30. The method of claim 29, in which a combination of the first inertial mass and the first piezoelectric element has a substantially nonidentical mechanical

vibration frequency response than the combination of the second inertial mass and the second piezoelectric element.

31. The method of claim 27, further characterizing the step of mechanically  
5 coupling an inertial mass to both of the first and second piezoelectric elements.

32. A method of sensing vibration of an auditory element in a middle ear, the method characterizing the steps of:

mechanically coupling a first piezoelectric element to the middle ear only  
10 through the auditory element; and

receiving a first electrical signal produced by the first piezoelectric element in response to the vibration of the auditory element.

33. The method of claim 32, further characterizing the steps of:

15 mechanically coupling a second piezoelectric element to the middle ear only through the auditory element; and

receiving a second electrical signal produced by the second piezoelectric element in response to the vibration of the auditory element.

20 34. The method of claim 33, in which the first and second piezoelectric elements have substantially nonidentical electrical frequency responses to the vibration of the auditory element.

35. The method of claim 33, further characterizing the steps of:

25 mechanically coupling a first inertial mass to the first piezoelectric element; and

mechanically coupling a second inertial mass to the second piezoelectric element.

30 36. The method of claim 29, in which a combination of the first inertial mass and the first piezoelectric element has a substantially nonidentical electrical

frequency response to the vibration of the auditory element than the combination of the second inertial mass and the second piezoelectric element.

37. The method of claim 33, further characterizing the step of mechanically  
5 coupling an inertial mass to both of the first and second piezoelectric elements.

38. An at least partially implantable hearing assistance system,  
characterizing:

an electromechanical transducer for an implantable hearing device, the  
10 transducer characterizing a piezoelectric element proportioned for mechanically  
coupling to a middle ear only through an auditory element in the middle ear;

an electronics unit, electrically coupled for providing the electrical input  
signal to the vibrator; and

a programmer, adapted for communicative coupling to the electronics  
15 unit.

39. The system of claim 38, in which the electromechanical transducer  
characterizes:

a carrier proportioned for mechanically coupling to a middle ear only  
20 through an auditory element in the middle ear; and

a first piezoelectric element mechanically coupled to the carrier for  
transducing between a mechanical vibration of the carrier and a first electrical  
signal.

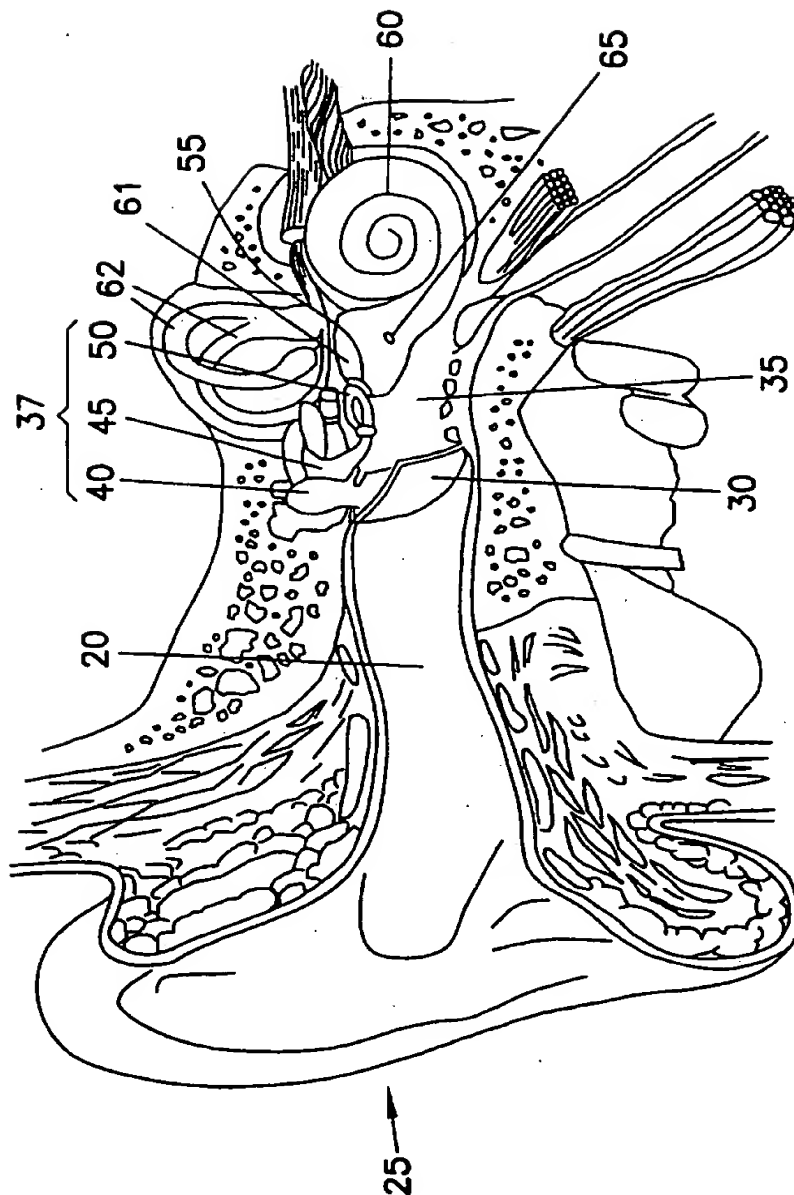


FIG. 1

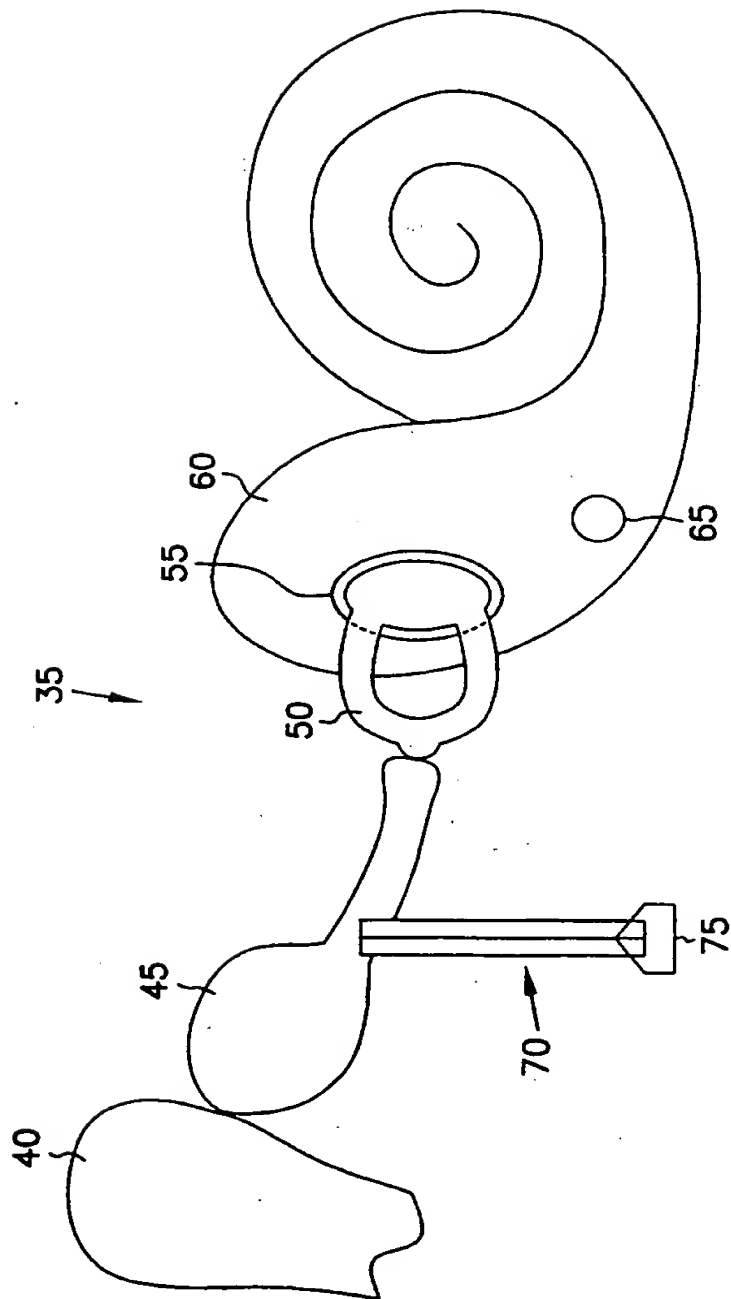


FIG. 2

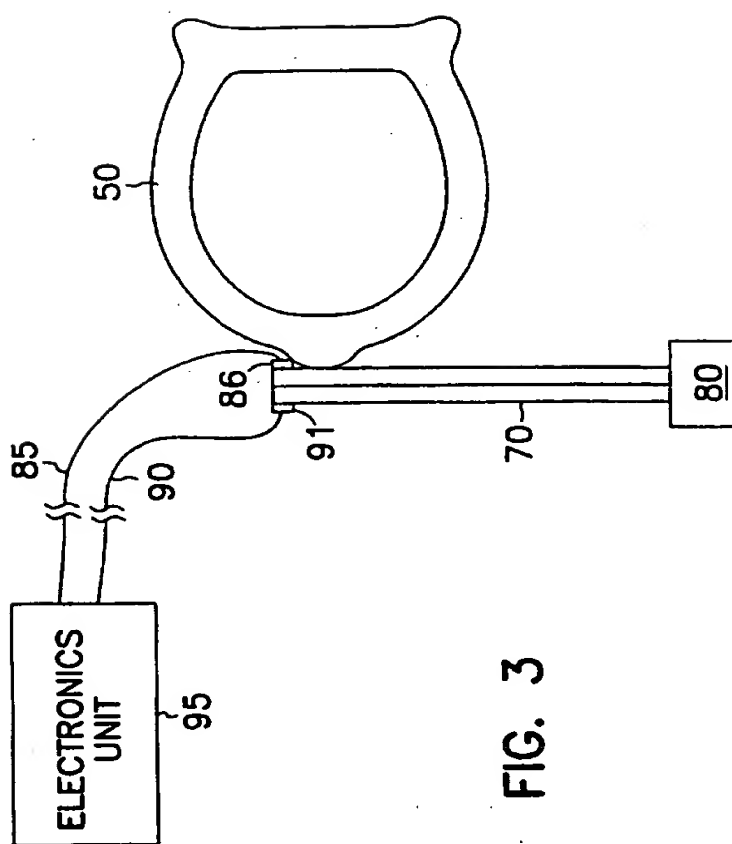


FIG. 3

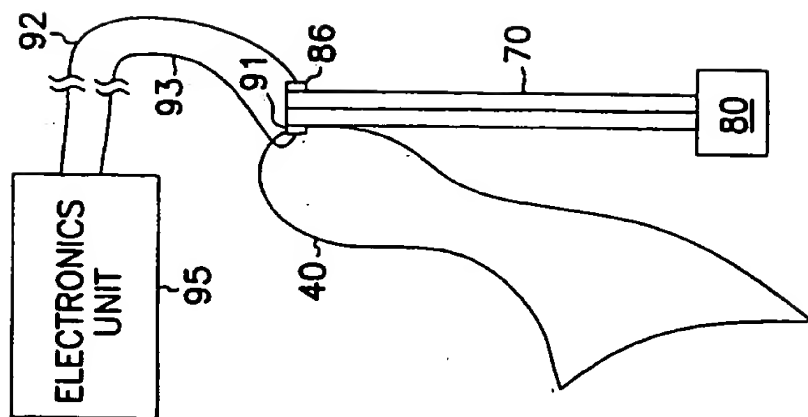


FIG. 4



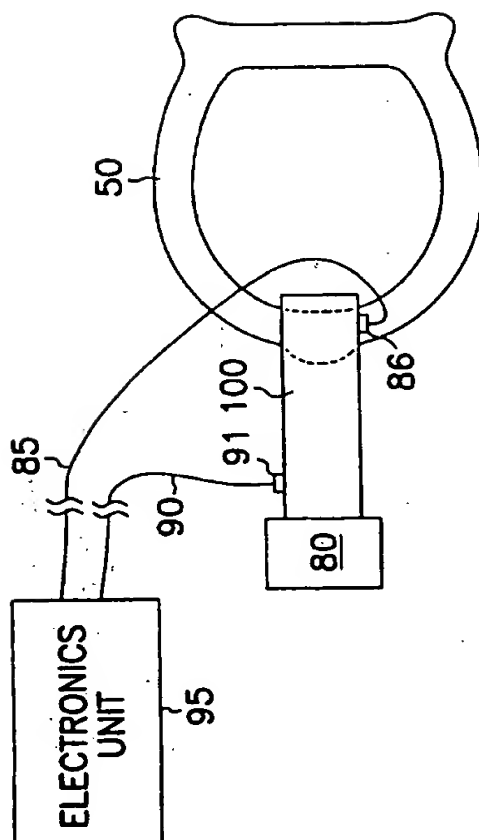


FIG. 5

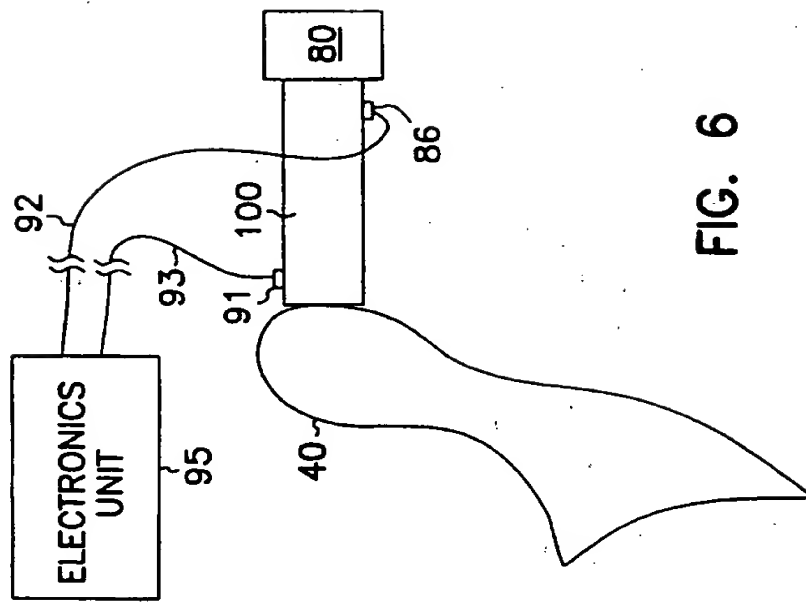


FIG. 6

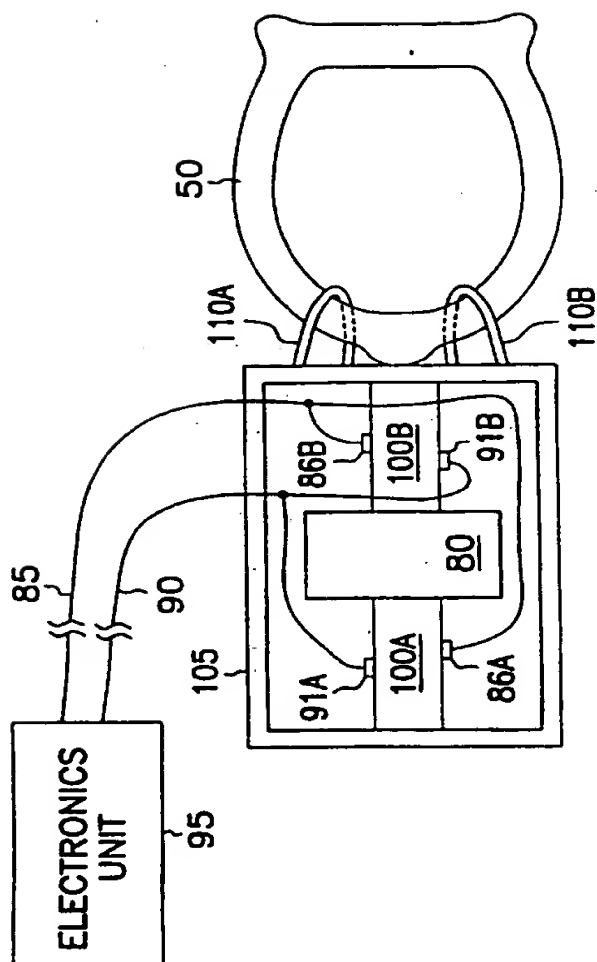


FIG. 7

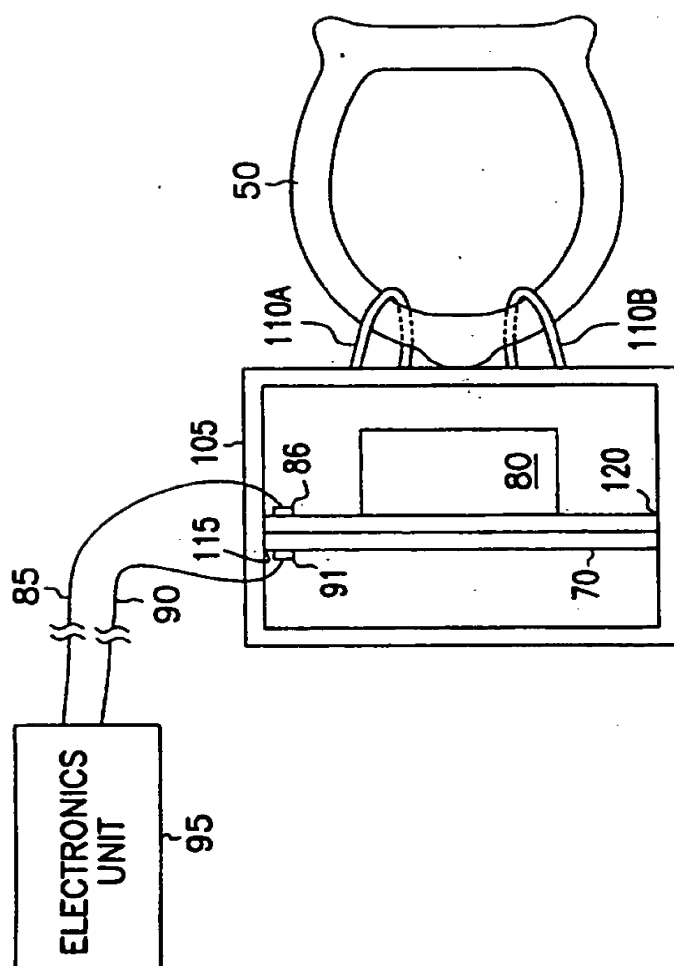


FIG. 8A

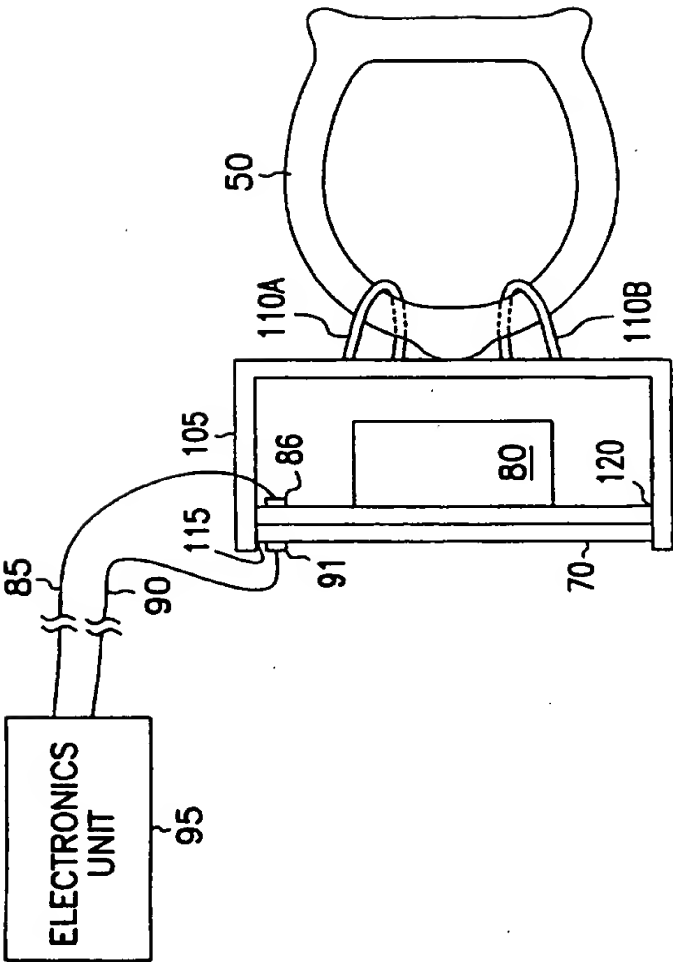
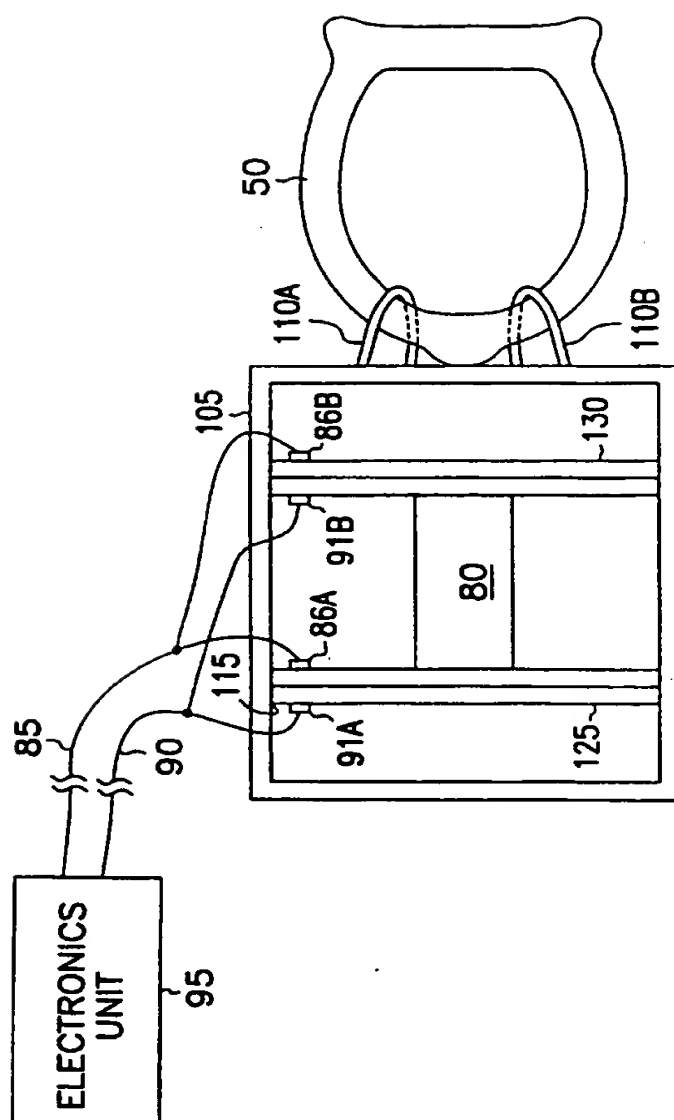


FIG. 8B



**FIG. 9**

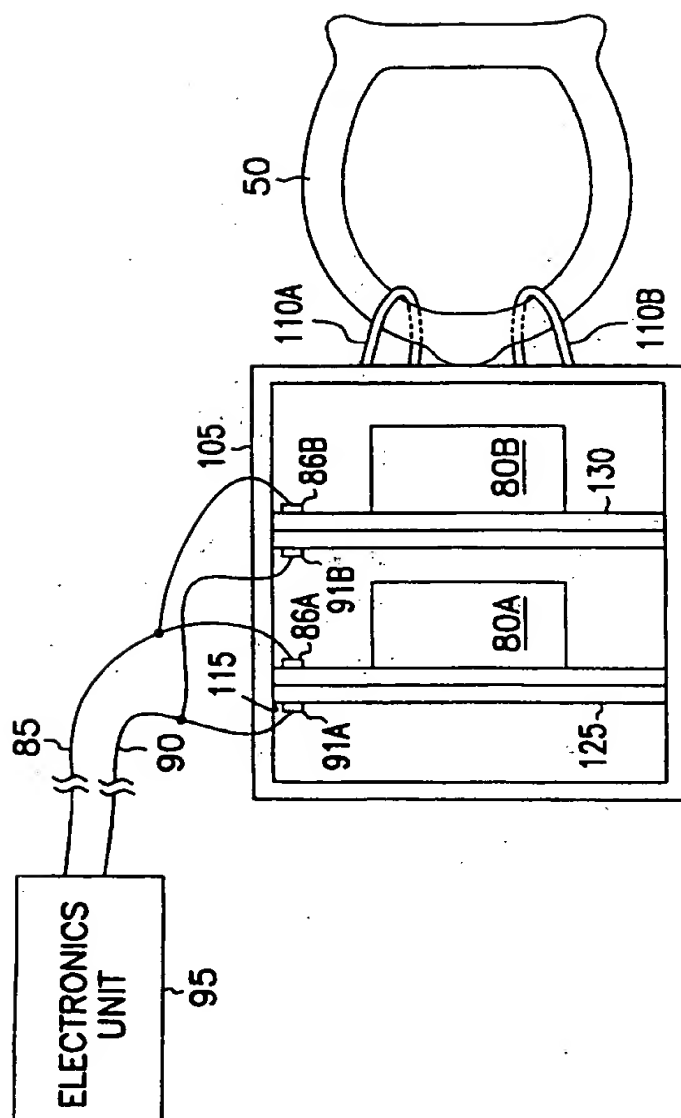


FIG. 10

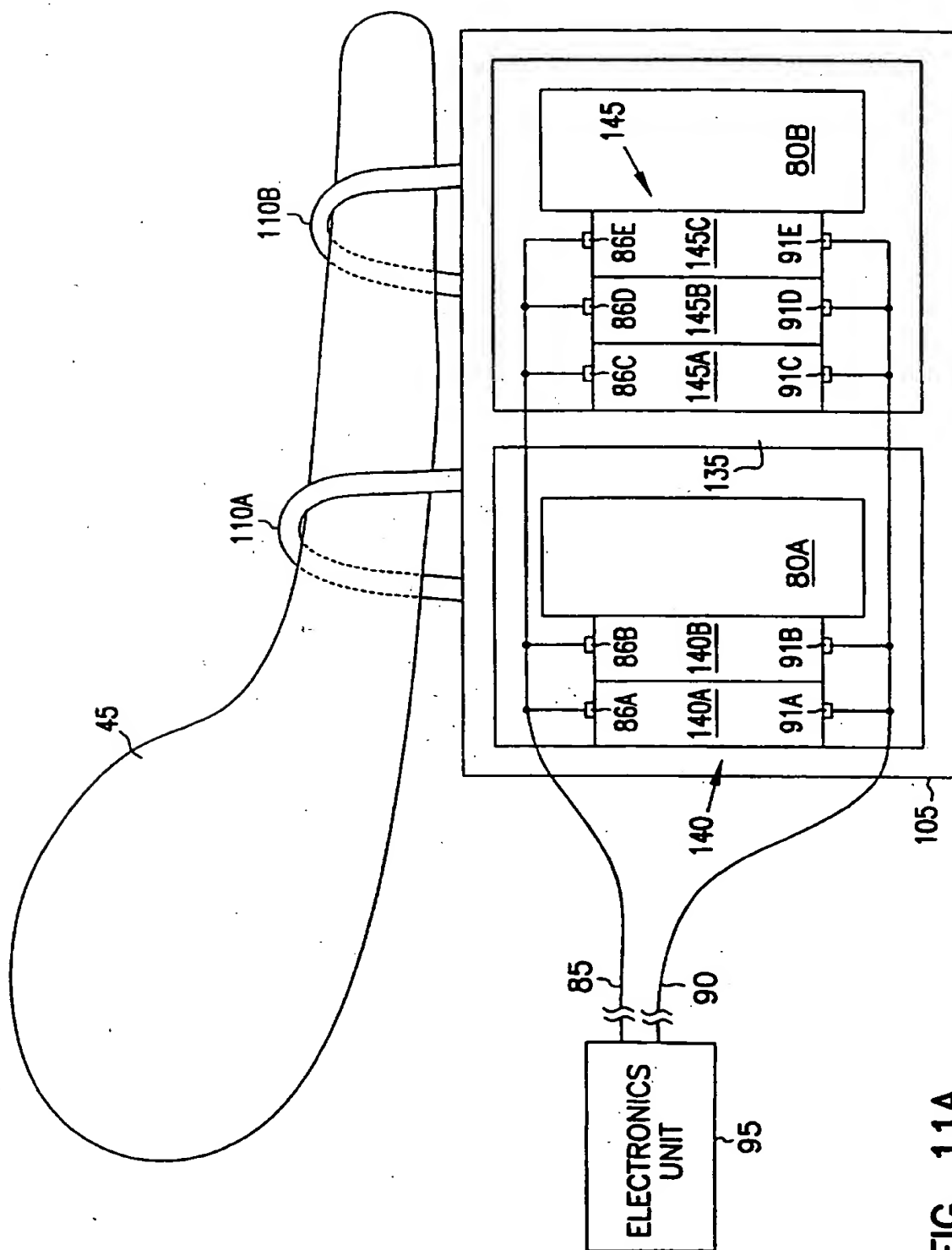


FIG. 11A



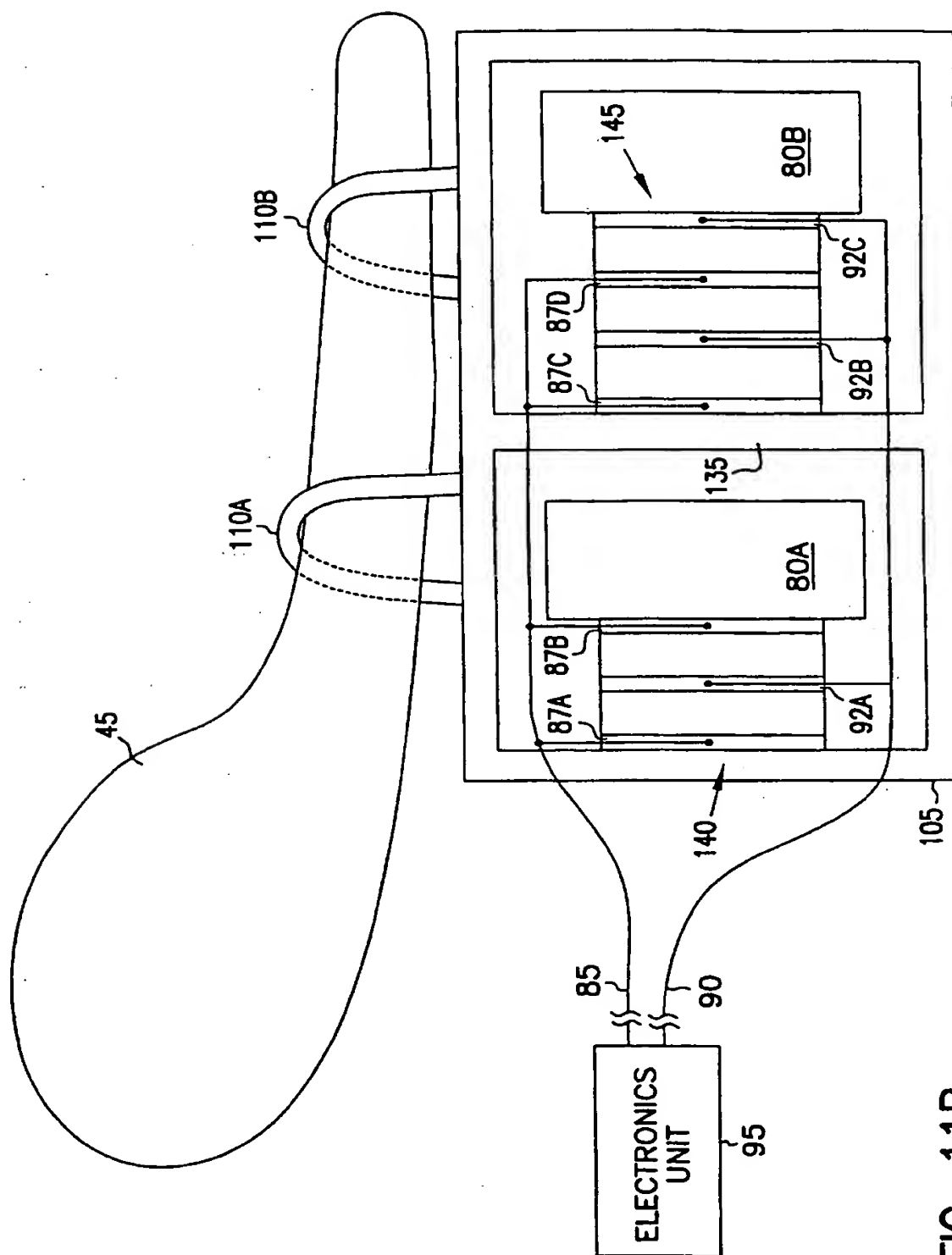


FIG. 11B

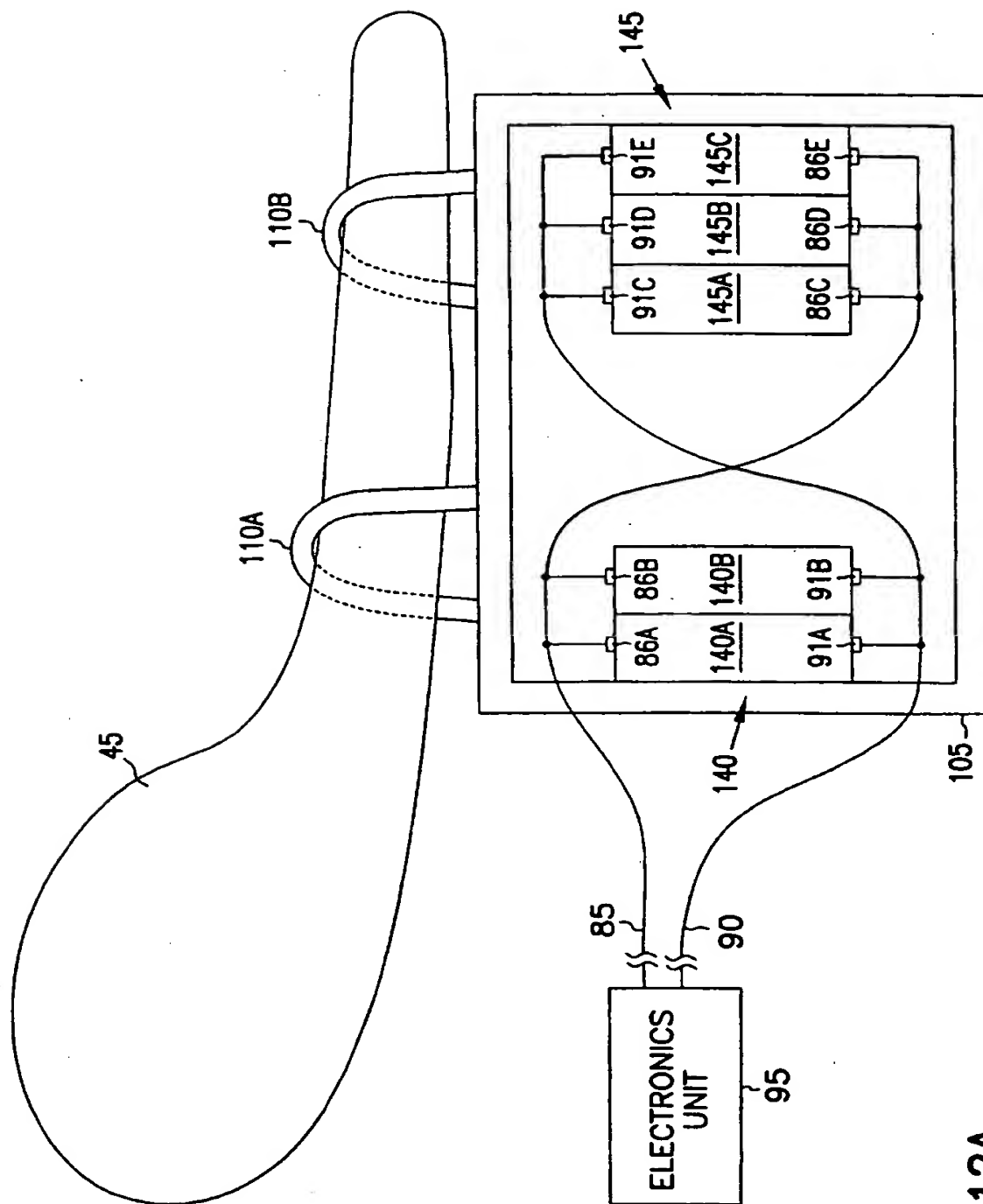


FIG. 12A

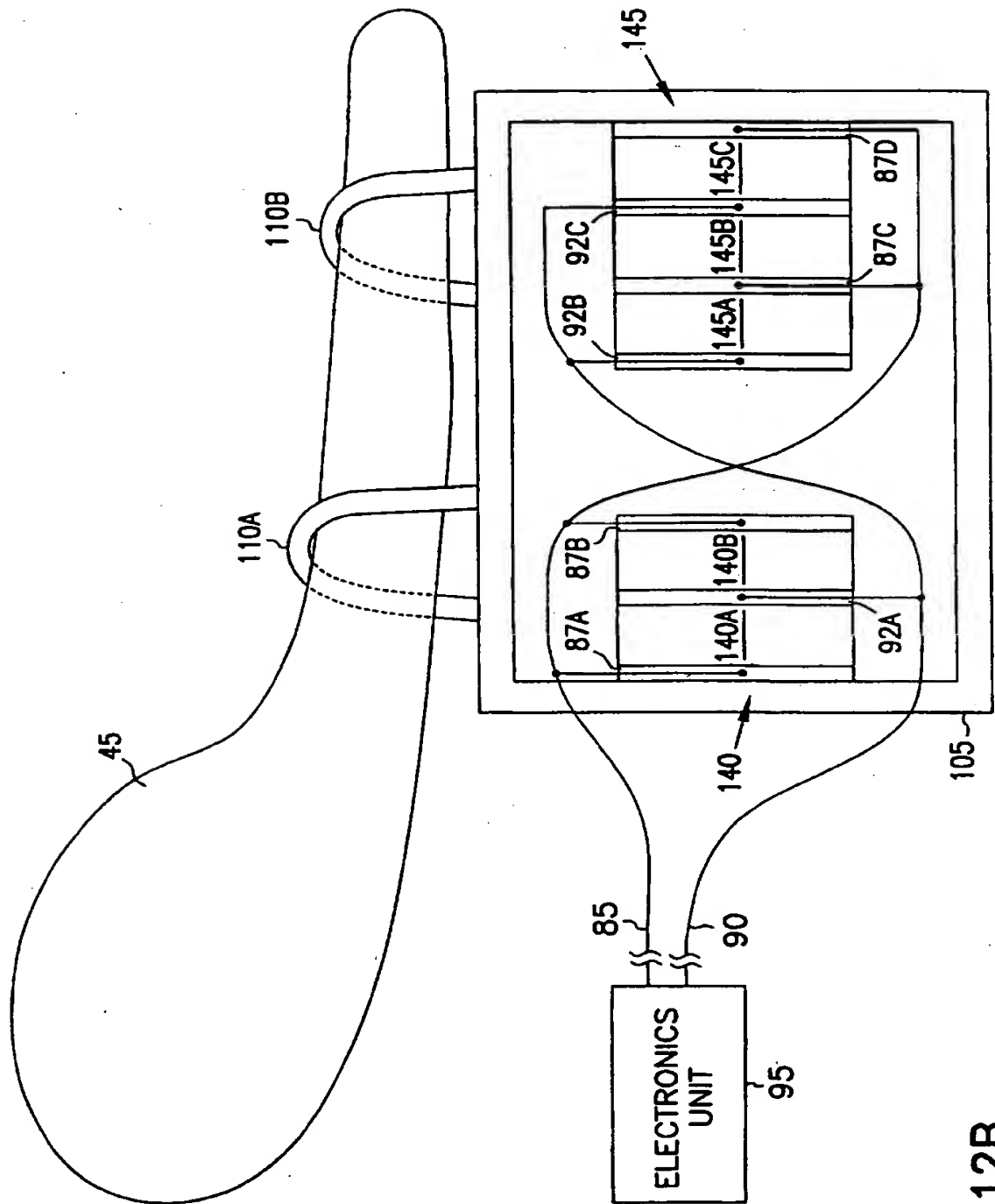


FIG. 12B

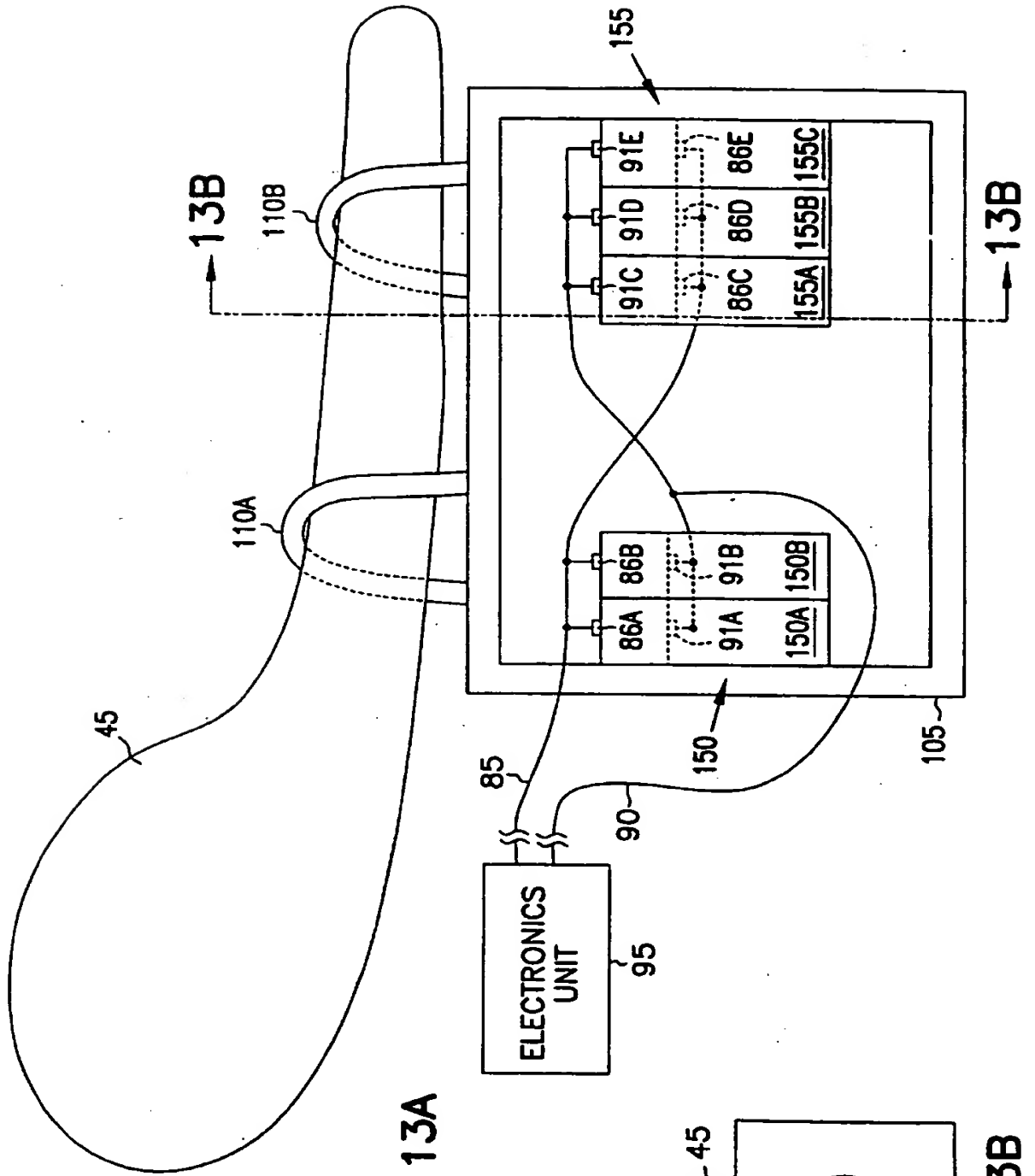


FIG. 13A

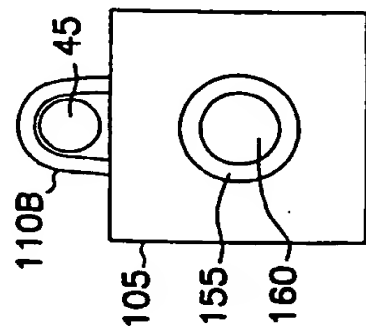
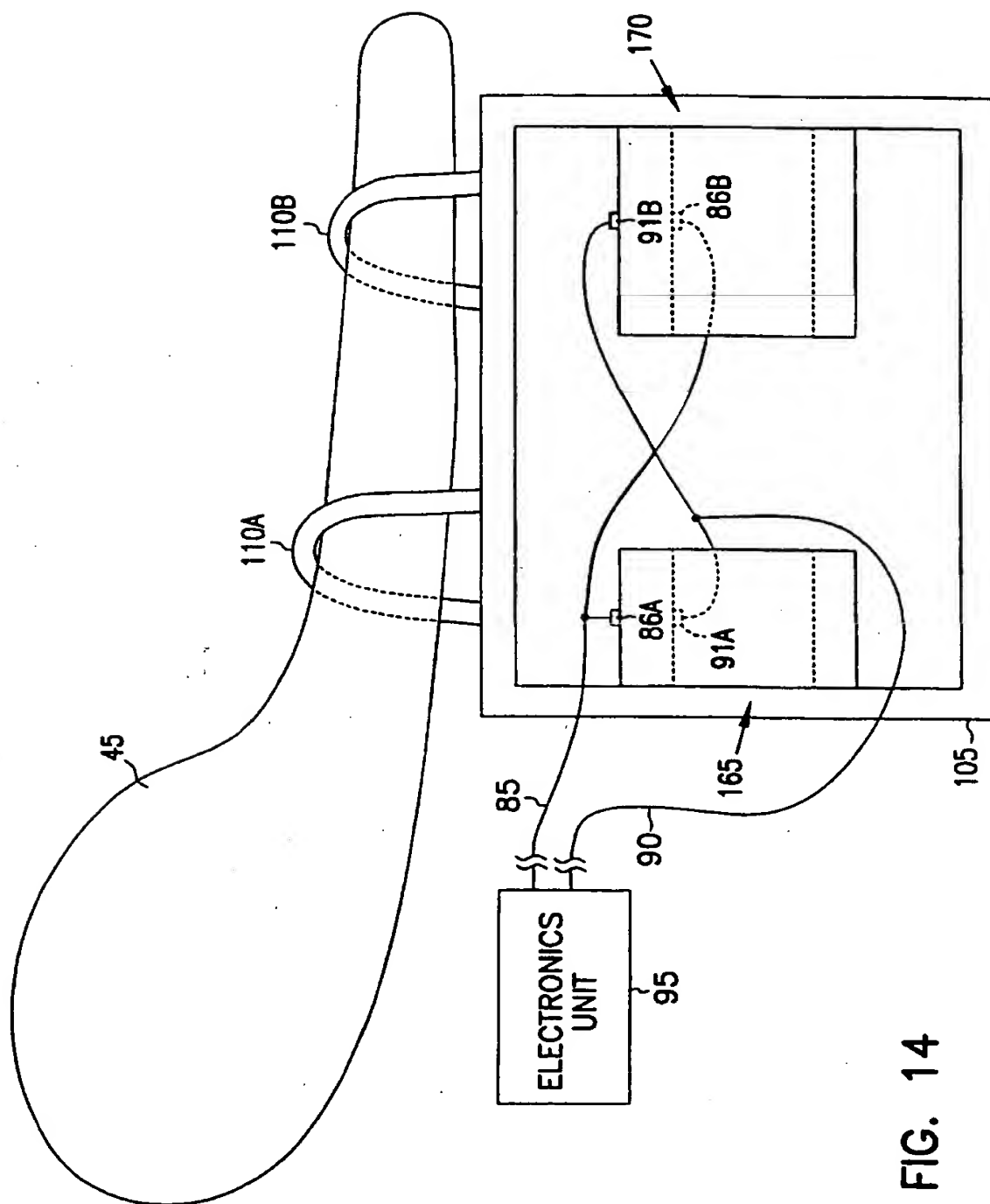
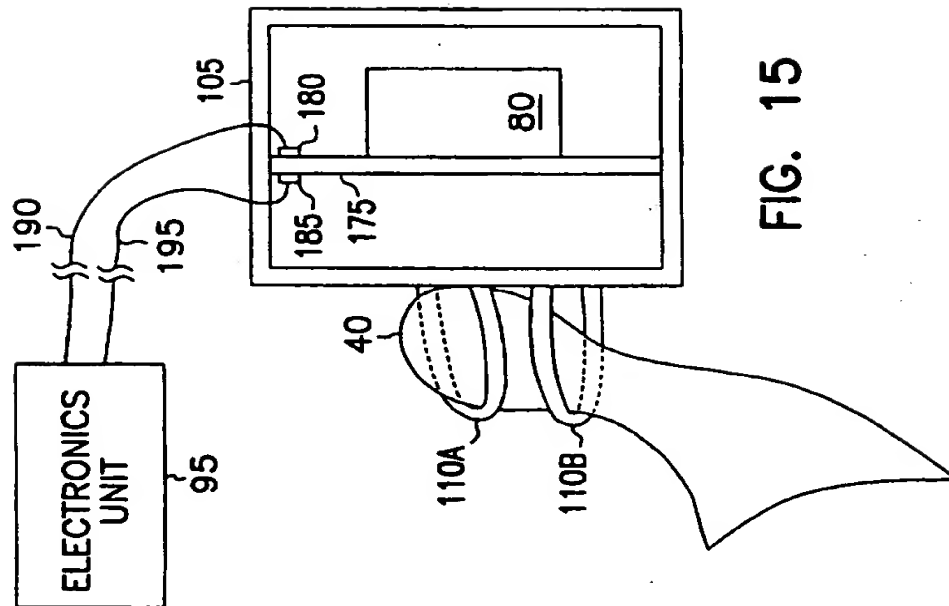


FIG. 13B





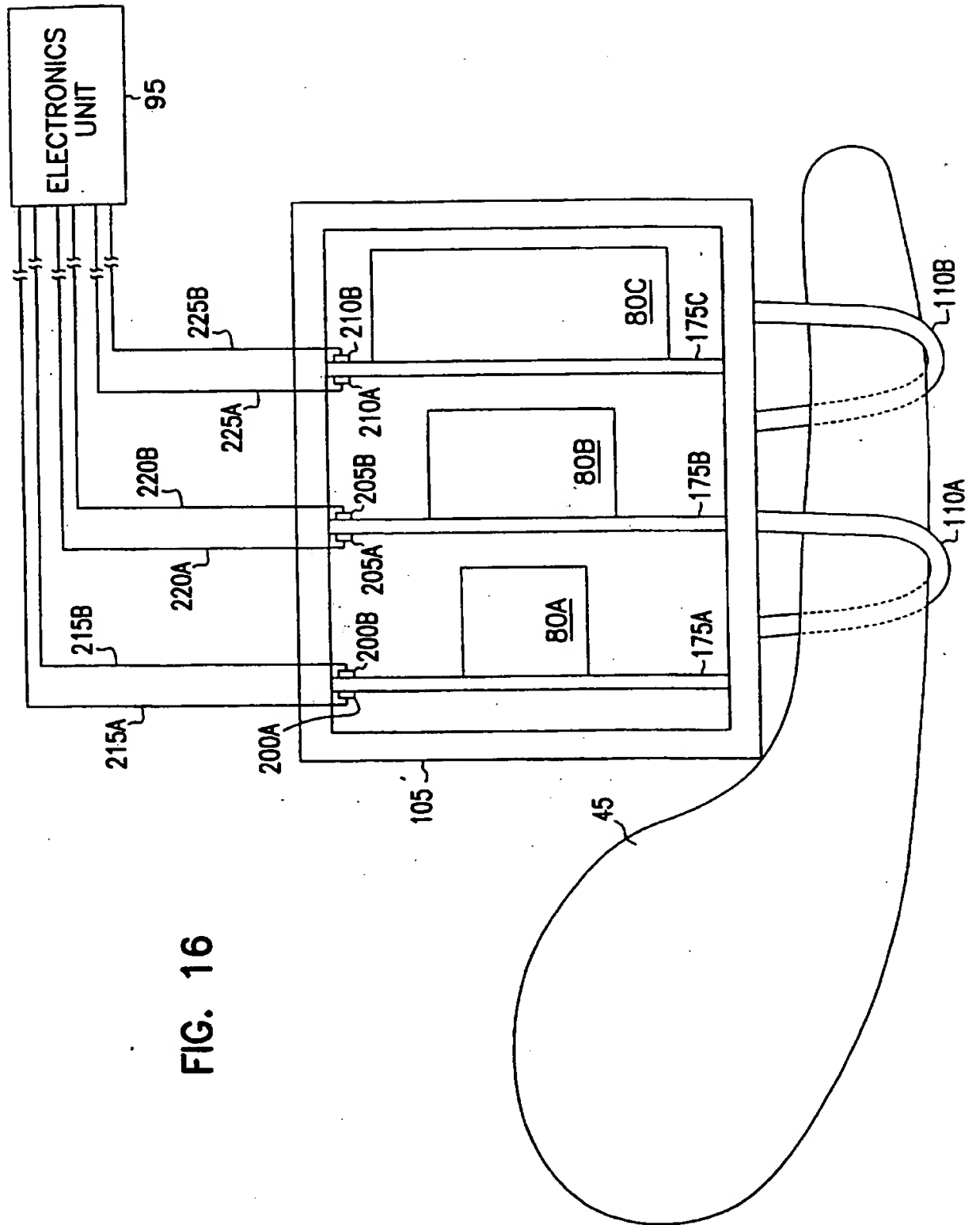


FIG. 16

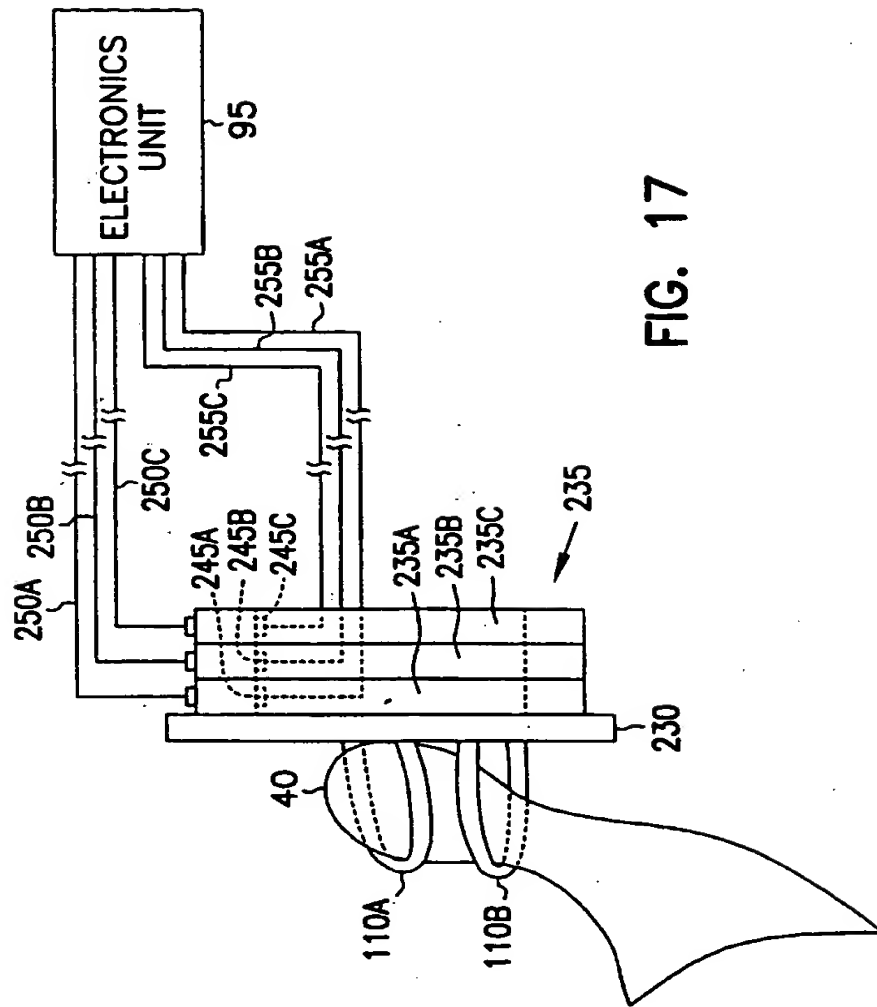


FIG. 17



FIG. 18

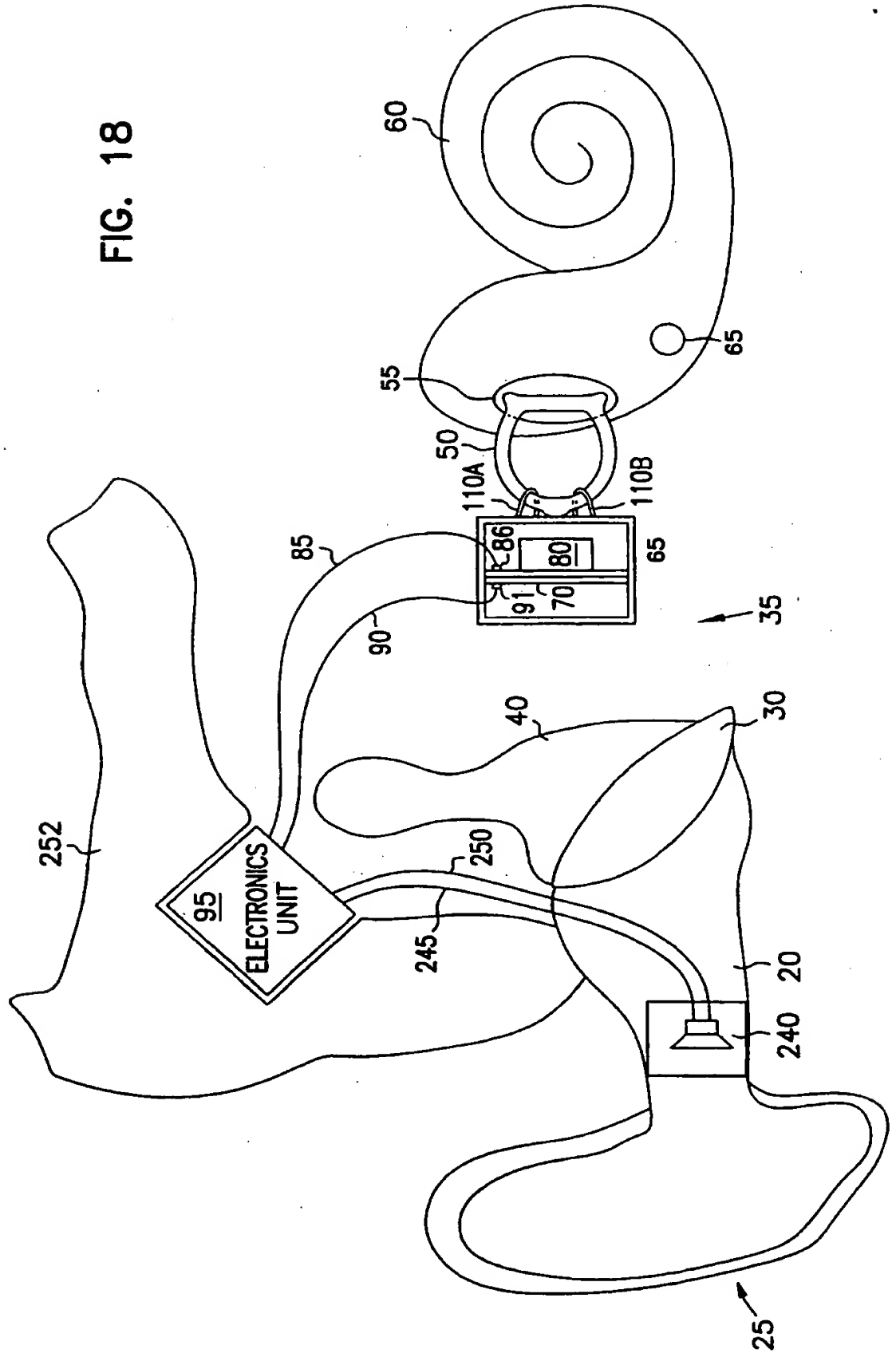
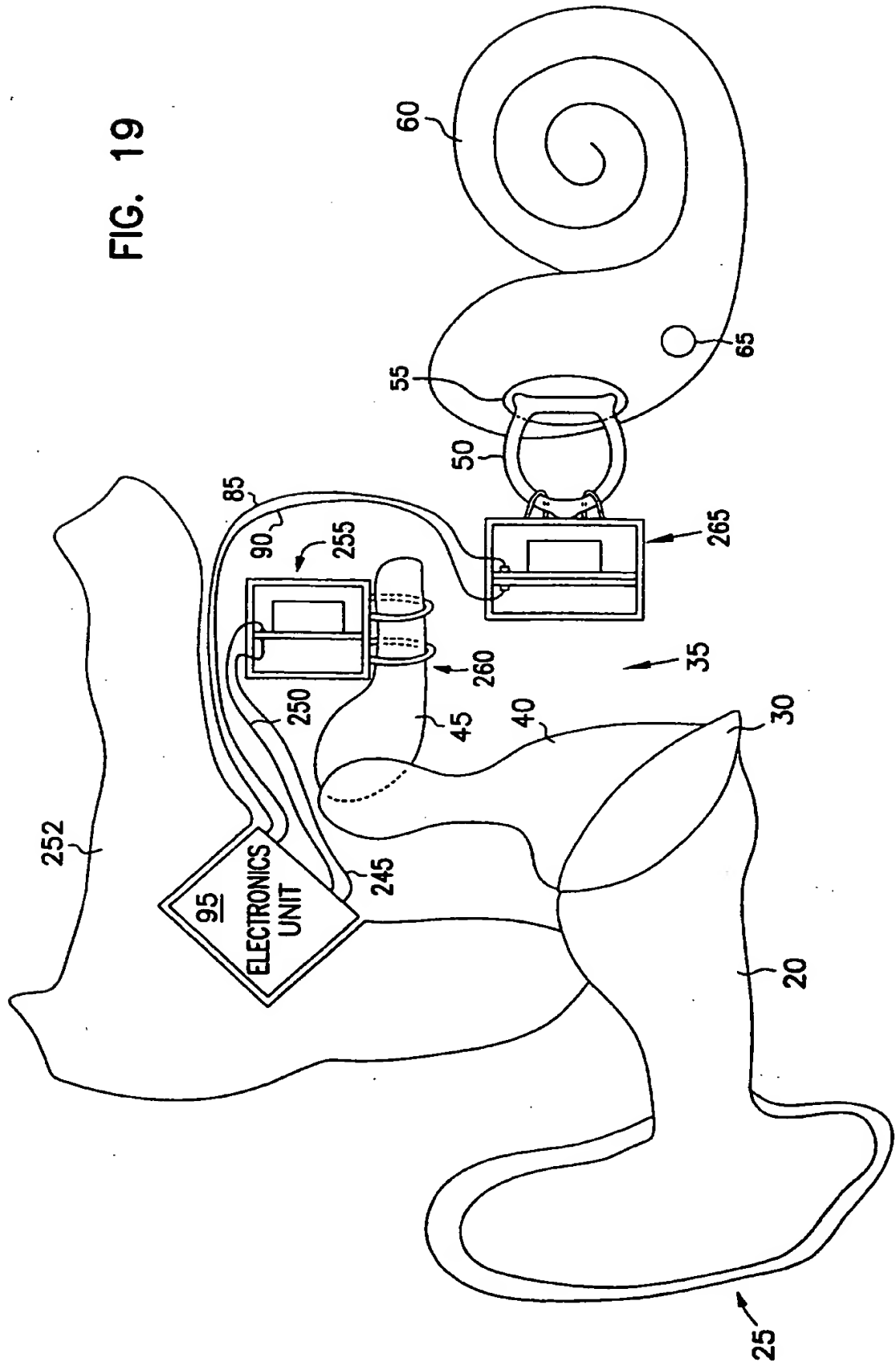


FIG. 19





## INTERNATIONAL SEARCH REPORT

Intern. Application No

PCT/US 97/13807

## A. CLASSIFICATION OF SUBJECT MATTER

IPC 6 H04R25/00

According to International Patent Classification (IPC) or to both national classification and IPC

## B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC 6 H04R A61F G01P B06B

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

## C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	WO 94 17645 A (AUDOTORY MICROMACHINES INC.) 4 August 1994	1,3,6-8
Y	see page 1, line 2-5	9,12-14, 21, 23-27, 32,33
A	see page 8, line 3 - page 11, line 20 see page 13, line 8 - page 14, line 6	4,5,10, 11, 15-20, 22, 28-31, 34-39
	see page 17, line 8 - page 43, line 17 --- -/-	



Further documents are listed in the continuation of box C.



Patent family members are listed in annex.

## \* Special categories of cited documents:

"A" document defining the general state of the art which is not considered to be of particular relevance

"E" earlier document but published on or after the international filing date

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"O" document referring to an oral disclosure, use, exhibition or other means

"P" document published prior to the international filing date but later than the priority date claimed

"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention

"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone

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"Z" document member of the same patent family

Date of the actual completion of the international search

31 October 1997

Date of mailing of the international search report

11.11.97

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Zanti, P

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Internat. Application No.  
PCT/US 97/13807

## C.(Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y	US 4 315 433 A (EDELMAN ET AL.) 16 February 1982	9,12-14, 21, 23-27, 32,33
A	see column 2, line 34 - column 3, line 34	1,2, 17-19, 22, 28-31, 34-37
X	US 3 712 962 A (EPLEY) 23 January 1973	1,3,4,7, 8
Y	see column 1, line 28-36	38
A	see column 2, line 51 - column 5, line 18	5,6, 9-12,15, 16, 19-21, 23,24, 26,28, 32,34,39
Y	WO 92 08330 A (COCHLEAR PTY.LIMITED) 14 May 1992 see page 1, line 1-5 see page 10, line 14 - page 11, line 24	38
A	US 3 594 514 A (WINGROVE) 20 July 1971 see column 1, line 38-52 see column 1, line 68 - column 3, line 12	1,4,7,9, 10,23
A	FR 2 365 267 A (ETAT FRANCAIS) 14 April 1978 see page 1, line 1-3 see page 2, line 5-12 see page 3, line 4-32	1,9,26, 32

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Information on patent family members

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PCT/US 97/13807

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FR 2365267 A	14-04-78	NONE	